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Note : Mitsubishi Electric will continue the business operations of high frequency \& optical devices and power devices.

Renesas Technology Corp. Customer Support Dept.
April 1, 2003

# MITSUBISHI MICROCOMPUTERS 3826 Group 

## DESCRIPTION

The 3826 group is the 8 -bit microcomputer based on the 740 family core technology.
The 3826 group has the LCD drive control circuit, an 8-channel A-D/D-A converter, UART and PWM as additional functions.
The various microcomputers in the 3826 group include variations of internal memory size and packaging. For details, refer to the section on part numbering
For details on availability of microcomputers in the 3826 Group, refer the section on group expansion.

## FEATURES

- Basic machine-language instructions .71
- The minimum instruction execution time $0.5 \mu \mathrm{~s}$
(at 8 MHz oscillation frequency)
- Memory size

ROM
32 K to 60 K bytes
RAM 1024 to 2560 bytes

- Programmable input/output ports ... 55
- Software pull-up resistors Built-in
- Output ports . 8
- Input ports $\qquad$
- Interrupts

17 sources, 16 vectors (includes key input interrupt)

- Timers $\qquad$ 8 -bit $\times 3,16$-bit $\times 2$
- Serial I/O1 $\qquad$ 8 -bit $\times 1$ (UART or Clock-synchronous)
- Serial I/O2 $\qquad$ 8 -bit $\times 1$ (Clock-synchronous)
- PWM output $\qquad$ 8 -bit $\times 1$
- A-D converter ................................................. 8-bit $\times 8$ channels
- D-A converter 8 -bit $\times 2$ channels (used as the DTMF and CTCSS function)
- LCD drive control circuit

Bias 1/2, 1/3
Duty
$1 / 2,1 / 3,1 / 4$
Common output .4
Segment output ........................................................................ 40

- 2 Clock generating circuits
(connect to external ceramic resonator or quartz-crystal oscillator)
- Watchdog timer .. 14-bit $\times 1$
- Power source voltage
2.5 to 5.5 V
- Power dissipation

In high-speed mode $\qquad$ 40 mW
(at 8 MHz oscillation frequency, at 5 V power source voltage)
In low-speed mode .. $60 \mu \mathrm{~W}$
(at 32 kHz oscillation frequency, at 3 V power source voltage)

- Operating temperature range
-20 to $85^{\circ} \mathrm{C}$


## APPLICATIONS

Camera, household appliances, consumer electronics, etc.

## PIN CONFIGURATION (TOP VIEW)



Package type : 100P6S-A
Fig. 1 Pin configuration of M38268MCLXXXFP

## PIN CONFIGURATION (TOP VIEW)



Package type : 100P6Q-A

Fig. 2 Pin configuration of M38268MCLXXXGP


Fig. 3 Functional block diagram

## PIN DESCRIPTION

Table 1 Pin description (1)

| Pin | Name | Function | Function except a port function |
| :---: | :---: | :---: | :---: |
| Vcc, Vss | Power source | -Apply voltage of 2.5 V to 5.5 V (2.2 V to 5.5 V for low voltage version) to Vcc, and 0 V to Vss. |  |
| Vref | Analog reference voltage | $\bullet$ Reference voltage input pin for A-D converter. |  |
| AVss | Analog power source | -GND input pin for A-D converter. <br> -Connect to Vss. |  |
| RESET | Reset input | -Reset input pin for active "L". |  |
| XIN | Clock input | -Input and output pins for the main clock generating circuit. <br> -Connect a ceramic resonator or a quartz-crystal oscillator between the XIN and Xout pins to set the oscillation frequency. <br> -If an external clock is used, connect the clock source to the Xin pin and leave the Xout pin open. A feedback resistor is built-in. |  |
| XOUT | Clock output |  |  |
| VL1-VL3 | LCD power source | - Input $0 \leq$ VL1 $\leq$ VL2 $\leq$ VL3 voltage. <br> -Input 0 - VL3 voltage to LCD. ( $0 \leq \mathrm{VL1} \leq \mathrm{VL2} \leq \mathrm{VL3}$ when a voltage is multiplied. $)$ |  |
| $\mathrm{C} 1, \mathrm{C} 2$ | Charge-pump capacitor pin | -External capacitor pins for a voltage multiplier (3 times) of LCD contorl. |  |
| COM0-COM3 | Common output | -LCD common output pins. <br> -COM2 and COM3 are not used at $1 / 2$ duty ratio. <br> -COM3 is not used at $1 / 3$ duty ratio. |  |
| SEG0-SEG17 | Segment output | -LCD segment output pins. |  |
| $\begin{aligned} & \text { P00/SEG26- } \\ & \text { P07/SEG33 } \end{aligned}$ | I/O port P0 | -8-bit I/O port. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -Pull-up control is enabled. <br> -I/O direction register allows each 8-bit pin to be programmed as either input or output. | -LCD segment output pins |
| $\begin{aligned} & \text { P10/SEG34- } \\ & \text { P15/SEG39 } \end{aligned}$ | I/O port P1 | -6-bit I/O port with same function as port PO. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -Pull-up control is enabled. <br> -I/O direction register allows each 6-bit pin to be programmed as either input or output. |  |
| P16, P17 |  | -2-bit I/O port. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -I/O direction register allows each pin to be individually programmred as either input or output. <br> -Pull-up control is enabled. |  |
| P20-P27 | I/O port P2 | $\cdot 8$-bit I/O port with same function as P16 and P17. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -Pull-up control is enabled. | -Key input (key-on wake-up) interrupt input pins |
| $\begin{aligned} & \text { P30/SEG18 - } \\ & \text { P37/SEG25 } \end{aligned}$ | Output port P3 | -8-bit output port with same function as port P0. <br> -CMOS 3-state output structure. <br> -Port output control is enabled. | -LCD segment output pins |

Table 2 Pin description (2)

| Pin | Name | Function | Function except a port function |
| :---: | :---: | :---: | :---: |
| P40 | I/O port P4 | -1-bit I/O port with same function as P16 and P17. <br> -CMOS compatible input level. <br> - N -channel open-drain output structure. |  |
| $\begin{aligned} & \text { P41/INT1, } \\ & \text { P42/INT2 } \end{aligned}$ |  | $\cdot 7$-bit I/O port with same function as P16 and P17. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -Pull-up control is enabled. | - Interrupt input pins |
| P43/¢/TOUT |  |  | - $\phi$ clock output pin <br> - Timer 2 output pin |
| $\begin{array}{\|l} \hline \text { P44/RXD, } \\ \text { P45/TxD, } \\ \text { P46/SCLK1, } \\ \text { P47/SRDY1 } \\ \hline \end{array}$ |  |  | - Serial I/O1 I/O pins |
| P50/PWM0, P51/PWM1 | I/O port P5 | $\cdot 8$-bit I/O port with same function as P16 and P17. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -Pull-up control is enabled. | -PWM function pins |
| P52/RTP0, P53/RTP1 |  |  | -Real time port function pins |
| P54/CNTR0, P55/CNTR1 |  |  | - Timer X, Y function pins |
| $\begin{aligned} & \hline \text { P56/DA1, } \\ & \text { P57/ADT/DA2 } \end{aligned}$ |  |  | -D-A conversion output pins |
| P6o/ANo/SIN2, P61/AN1/Sout2, P62/AN2/ScLK21, P63/AN3/ScLK22 | I/O port P6 | $\cdot 8$-bit I/O port with same function as P16 and P17. <br> -CMOS compatible input level. <br> -CMOS 3-state output structure. <br> -Pull-up control is enabled. | -A-D conversion input pins <br> -Serial I/O2 I/O pins |
| $\begin{aligned} & \text { P64/AN4- } \\ & \text { P67/AN7 } \end{aligned}$ |  |  | -A-D conversion input pins |
| P70/INT0 | Input port P7 | -1-bit input port. | - Interrupt input pin |
| P71-P77 | I/O port P7 | $\cdot 7$-bit I/O port with same function as P16 and P17. <br> -CMOS compatible input level. <br> - N -channel open-drain output structure. |  |
| Xcout | Sub-clock output | - Sub-clock generating circuit I/O pins. <br> (Connect a resonator. External clock cannot be used.) |  |
| XCIN | Sub-clock input |  |  |

## PART NUMBERING



Fig. 4 Part numbering

## GROUP EXPANSION <br> (One Time PROM Version, EPROM Version)

Mitsubishi plans to expand the 3826 group (One Time PROM version, EPROM version) as follows.

## Packages

100P6Q-A $\qquad$ 0.5 mm -pitch plastic molded QFP 100P6S-A 0.65 mm -pitch plastic molded QFP 100D0 Ceramic LCC (EPROM version)

## Memory Type

Support for One Time PROM version, EPROM version.

## Memory Size

ROM/PROM size
RAM size 1024 to 2560 bytes

## 3826 Group Memory Expansion Plan (One Time PROM version, EPROM version)



Products under development or planning :the development schedule and specification may be revised without notice.
Fig. 5 Memory expansion plan (One Time PROM version, EPROM version)
Currently products are listed below.

Table 3. List of products (One Time PROM version, EPROM version)
As of Nov. 2001

| Product | ROM size (bytes) ROM size for User in ( ) | RAM size (bytes) | Package | Remarks |
| :---: | :---: | :---: | :---: | :---: |
| M38267E8FP | $\begin{gathered} 32768 \\ (32638) \end{gathered}$ | 1024 | 100P6S-A | One Time PROM version (shipped in blank) |
| M38267E8GP |  |  | 100P6Q-A | One Time PROM version (shipped in blank) |
| M3826AEFFP | $\begin{gathered} 61440 \\ (61310) \end{gathered}$ | 2560 | 100P6S-A | One Time PROM version (shipped in blank) |
| M3826AEFGP |  |  | 100P6Q-A | One Time PROM version (shipped in blank) |
| M3826AEFFS |  |  | 100D0 | EPROM version |

GROUP EXPANSION (Low Voltage Version)
Mitsubishi plans to expand the 3826 group (low voltage version) as follows.

## Packages

100P6Q-A
0.5 mm-pitch plastic molded QFP

100P6S-A 0.65 mm -pitch plastic molded QFP

## Memory Type

Support for Mask ROM version.

## Memory Size

ROM/PROM size .
32 K to 60 K bytes
RAM size 1024 to 2560 bytes

## 3826 Group Memory Expansion Plan (Low voltage version)



Products under development or planning :the development schedule and specification may be revised without notice.

Fig. 6 Memory expansion plan (Low voltage version)

Currently products are listed below.

Table 4. List of products (Low voltage version)
As of Nov. 2001

| Product | ROM size (bytes) ROM size for User in ( ) | RAM size (bytes) | Package | Remarks |
| :---: | :---: | :---: | :---: | :---: |
| M38267M8LXXXFP | $\begin{gathered} 32768 \\ (32638) \end{gathered}$ | 1024 | 100P6S-A | Mask ROM version |
| M38267M8LXXXGP |  |  | 100P6Q-A | Mask ROM version |
| M38268MCLXXXFP | $\begin{gathered} 49152 \\ (49022) \end{gathered}$ | 1536 | 100P6S-A | Mask ROM version |
| M38268MCLXXXGP |  |  | 100P6Q-A | Mask ROM version |
| M3826AMFLXXXFP | $\begin{gathered} 61440 \\ (61310) \end{gathered}$ | 2560 | 100P6S-A | Mask ROM version |
| M3826AMFLXXXGP |  |  | 100P6Q-A | Mask ROM version |

## FUNCTIONAL DESCRIPTION

## CENTRAL PROCESSING UNIT (CPU)

The 3826 group uses the standard 740 family instruction set. Refer to the table of 740 family addressing modes and machine instructions or the 740 Family Software Manual for details on the instruction set.
Machine-resident 740 family instructions are as follows:
The FST and SLW instruction cannot be used.
The STP, WIT, MUL, and DIV instruction can be used.

## [Accumulator (A)]

The accumulator is an 8-bit register. Data operations such as data transfer, etc., are executed mainly through the accumulator.

## [Index Register X (X)]

The index register X is an 8 -bit register. In the index addressing modes, the value of the OPERAND is added to the contents of register X and specifies the real address.

## [Index Register Y (Y)]

The index register $Y$ is an 8-bit register. In partial instruction, the value of the OPERAND is added to the contents of register Y and specifies the real address.

## [Stack Pointer (S)]

The stack pointer is an 8-bit register used during subroutine calls and interrupts. This register indicates start address of stored area (stack) for storing registers during subroutine calls and interrupts. The low-order 8 bits of the stack address are determined by the contents of the stack pointer. The high-order 8 bits of the stack address are determined by the stack page selection bit. If the stack page selection bit is " 0 ", the high-order 8 bits becomes "0016". If the stack page selection bit is " 1 ", the high-order 8 bits becomes "0116".
The operations of pushing register contents onto the stack and popping them from the stack are shown in Figure 8.
Store registers other than those described in Figure 8 with program when the user needs them during interrupts or subroutine calls.

## [Program Counter (PC)]

The program counter is a 16 -bit counter consisting of two 8 -bit registers PCH and PCL . It is used to indicate the address of the next instruction to be executed.


Fig. 7740 Family CPU register structure


Fig. 8 Register push and pop at interrupt generation and subroutine call
Table 5 Push and pop instructions of accumulator or processor status register

|  | Push instruction to stack | Pop instruction from stack |
| :--- | :---: | :---: |
| Accumulator | PHA | PLA |
| Processor status register | PHP | PLP |

## [Processor status register (PS)]

The processor status register is an 8-bit register consisting of 5 flags which indicate the status of the processor after an arithmetic operation and 3 flags which decide MCU operation. Branch operations can be performed by testing the Carry (C) flag, Zero (Z) flag, Overflow (V) flag, or the Negative (N) flag. In decimal mode, the Z, $\mathrm{V}, \mathrm{N}$ flags are not valid.

- Bit 0: Carry flag (C)

The C flag contains a carry or borrow generated by the arithmetic logic unit (ALU) immediately after an arithmetic operation. It can also be changed by a shift or rotate instruction.

- Bit 1: Zero flag (Z)

The $Z$ flag is set if the result of an immediate arithmetic operation or a data transfer is " 0 ", and cleared if the result is anything other than " 0 ".

- Bit 2: Interrupt disable flag (I)

The I flag disables all interrupts except for the interrupt generated by the BRK instruction.
Interrupts are disabled when the I flag is " 1 ".

- Bit 3: Decimal mode flag (D)

The D flag determines whether additions and subtractions are executed in binary or decimal. Binary arithmetic is executed when this flag is " 0 "; decimal arithmetic is executed when it is "1".

Decimal correction is automatic in decimal mode. Only the ADC and SBC instructions can be used for decimal arithmetic.

- Bit 4: Break flag (B)

The $B$ flag is used to indicate that the current interrupt was generated by the BRK instruction. The BRK flag in the processor status register is always " 0 ". When the BRK instruction is used to generate an interrupt, the processor status register is pushed onto the stack with the break flag set to "1".

- Bit 5: Index X mode flag (T)

When the T flag is " 0 ", arithmetic operations are performed between accumulator and memory. When the T flag is " 1 ", direct arithmetic operations and direct data transfers are enabled between memory locations.

- Bit 6: Overflow flag (V)

The V flag is used during the addition or subtraction of one byte of signed data. It is set if the result exceeds +127 to -128 . When the BIT instruction is executed, bit 6 of the memory location op erated on by the BIT instruction is stored in the overflow flag.

- Bit 7: Negative flag (N)

The N flag is set if the result of an arithmetic operation or data transfer is negative. When the BIT instruction is executed, bit 7 of the memory location operated on by the BIT instruction is stored in the negative flag.

Table 6 Set and clear instructions of each bit of processor status register

|  | C flag | Z flag | I flag | D flag | B flag | T flag | V flag | N flag |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Set instruction | SEC | - | SEI | SED | - | SET | - | - |
| Clear instruction | CLC | - | CLI | CLD | - | CLT | CLV | - |

## [CPU Mode Register (CPUM)] 003B16

The CPU mode register contains the stack page selection bit and the internal system clock selection bit.
The CPU mode register is allocated at address 003B16.


Fig. 9 Structure of CPU mode register

## MEMORY <br> Special Function Register (SFR) Area

The Special Function Register area in the zero page contains control registers such as I/O ports and timers

## RAM

RAM is used for data storage and for stack area of subroutine calls and interrupts.

## ROM

The first 128 bytes and the last 2 bytes of ROM are reserved for device testing and the rest is user area for storing programs.

## Interrupt Vector Area

The interrupt vector area contains reset and interrupt vectors.

## Zero Page

The 256 bytes from addresses 000016 to 00FF16 are called the zero page area. The internal RAM and the special function registers (SFR) are allocated to this area.
The zero page addressing mode can be used to specify memory and register addresses in the zero page area. Access to this area with only 2 bytes is possible in the zero page addressing mode.

## Special Page

The 256 bytes from addresses FF0016 to FFFF16 are called the special page area. The special page addressing mode can be used to specify memory addresses in the special page area. Access to this area with only 2 bytes is possible in the special page addressing mode.

RAM area

| RAM size <br> (bytes) | Address <br> XXXX16 $^{2}$ |
| :---: | :---: |
| 192 | 00FF $_{16}$ |
| 256 | $0^{013 F_{16}}$ |
| 384 | $0^{01 \mathrm{BF}_{16}}$ |
| 512 | $0^{023 F_{16}}$ |
| 640 | $0^{02 \mathrm{BF}_{16}}$ |
| 768 | $0^{033 F_{16}}$ |
| 896 | $03 \mathrm{BF}_{16}$ |
| 1024 | $043 \mathrm{~F}_{16}$ |
| 1536 | $063 \mathrm{~F}_{16}$ |
| 2048 | $083 \mathrm{~F}_{16}$ |
| 2560 | $0 \mathrm{~A}_{16} 16$ |

ROM area

| ROM size (bytes) | Address YYYY16 | Address $Z_{Z Z Z}^{16}$ |
| :---: | :---: | :---: |
| 4096 | F00016 | F08016 |
| 8192 | E00016 | E08016 |
| 12288 | D00016 | D08016 |
| 16384 | C00016 | C08016 |
| 20480 | B00016 | B08016 |
| 24576 | A00016 | A08016 |
| 28672 | 900016 | 908016 |
| 32768 | 800016 | 808016 |
| 36864 | 700016 | 708016 |
| 40960 | 600016 | 608016 |
| 45056 | 500016 | 508016 |
| 49152 | 400016 | 408016 |
| 53248 | 300016 | 308016 |
| 57344 | 200016 | 208016 |
| 61440 | 100016 | 108016 |

Note: When RAM area exceeds 1024 bytes, the areas shown the table are used

Fig. 10 Memory map diagram

| 000016 | Port P0 (P0) | 002016 | Timer X (low) (TXL) |
| :---: | :---: | :---: | :---: |
| 000116 | Port P0 direction register (POD) | 002116 | Timer X (high) (TXH) |
| 000216 | Port P1 (P1) | 002216 | Timer Y (low) (TYL) |
| 000316 | Port P1 direction register (P1D) | 002316 | Timer Y (high) (TYH) |
| 000416 | Port P2 (P2) | 002416 | Timer 1 (T1) |
| 000516 | Port P2 direction register (P2D) | 002516 | Timer 2 (T2) |
| 000616 | Port P3 (P3) | 002616 | Timer 3 (T3) |
| 000716 | Port P3 output control register (P3C) | 002716 | Timer X mode register (TXM) |
| 000816 | Port P4 (P4) | 002816 | Timer Y mode register (TYM) |
| 000916 | Port P4 direction register (P4D) | 002916 | Timer 123 mode register (T123M) |
| 000A16 | Port P5 (P5) | 002A16 | Tout/ $\phi$ output control register (CKOUT) |
| 000B16 | Port P5 direction register (P5D) | 002B16 | PWM control register (PWMCON) |
| 000C16 | Port P6 (P6) | 002C16 | PWM prescaler (PREPWM) |
| 000D16 | Port P6 direction register (P6D) | 002D16 | PWM register (PWM) |
| 000E16 | Port P7 (P7) | 002E16 | CTCSS timer (low) (CTCSSL) |
| 000F16 | Port P7 direction register (P7D) | 002F16 | CTCSS timer (high) (CTCSSH) |
| 001016 |  | 003016 | DTMF high group timer (DTMFH) |
| 001116 |  | 003116 | DTMF low group timer (DTMFL) |
| 001216 |  | 003216 | D-A1 conversion register (DA1) |
| 001316 |  | 003316 | D-A2 conversion register (DA2) |
| 001416 | Reserved area (Note) | 003416 | A-D control register (ADCON) |
| 001516 | Key input control register (KIC) | 003516 | A-D conversion register (AD) |
| 001616 | PULL register A (PULLA) | 003616 | D-A control register (DACON) |
| 001716 | PULL register B (PULLB) | 003716 | Watchdog timer control register (WDTCON) |
| 001816 | Transmit/Receive buffer register(TB/RB) | 003816 | Segment output enable register (SEG) |
| 001916 | Serial I/O1 status register (SIO1STS) | 003916 | LCD mode register (LM) |
| 001A16 | Serial I/O1 control register (SIO1CON) | 003A16 | Interrupt edge selection register (INTEDGE) |
| 001B16 | UART control register (UARTCON) | 003B16 | CPU mode register (CPUM) |
| 001C16 | Baud rate generator (BRG) | 003C16 | Interrupt request register 1(IREQ1) |
| 001D16 | Serial I/O2 control register (SIO2CON) | 003D16 | Interrupt request register 2(IREQ2) |
| 001E16 | Reserved area (Note) | 003E16 | Interrupt control register 1(ICON1) |
| 001F16 | Serial I/O2 register (SIO2) | 003F16 | Interrupt control register 2(ICON2) |
| Note: The register of reserved area can not be used. |  |  |  |

Fig. 11 Memory map of special function register (SFR)

## I/O PORTS

## Direction Registers

The I/O ports (ports P0, P1, P2, P4, P5, P6, P71-P77) have direction registers which determine the input/output direction of each individual pin. (Ports $\mathrm{P} 00-\mathrm{P} 07$ are shared with bit 0 of the port P0 direction register, and ports $\mathrm{P} 10-\mathrm{P} 15$ shared with bit 0 of the port P1 direction register.) Each bit in a direction register corresponds to one pin, and each pin can be set to be input port or output port. When " 0 " is written to the bit corresponding to a pin, that pin becomes an input pin. When " 1 " is written to that bit, that pin becomes an output pin.
If data is read from a pin set to output, the value of the port output latch is read, not the value of the pin itself. Pins set to input are floating. If a pin set to input is written to, only the port output latch is written to and the pin remains floating.

## Port P3 Output Control Register

Bit 0 of the port P3 output control register (address 000716) enables control of the output of ports P30-P37.
When the bit is set to " 1 ", the port output function is valid.
When resetting, bit 0 of the port P3 output control register is set to " 0 " (the port output function is invalid) and pulled up.

## Pull-up Control

By setting the PULL register A (address 001616) or the PULL register B (address 001716), ports P0 to P2, P4 to P6 can control pullup with a program.
However, the contents of PULL register A and PULL register B do not affect ports programmed as the output ports.
The PULL register A setting is invalid for pins set to segment output with the segment output enable register.


0 : Disable
1 : Enable
Note: The contents of PULL register A and PULL register B do not affect ports programmed as the output port.

Fig. 12 Structure of PULL register A and PULL register B

Table $\mathbf{7}$ List of I/O port function (1)

| Pin | Name | Input/Output | I/O Format | Non-Port Function | Related SFRs | Diagram No. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { P00/SEG26- } \\ & \text { P07/SEG33 } \end{aligned}$ | Port P0 | Input/output, byte unit | CMOS compatible input level CMOS 3-state output | LCD segment output | PULL register A <br> Segment output enable register | (1) (2) |
| $\begin{aligned} & \text { P10/SEG34- } \\ & \text { P15/SEG39 } \end{aligned}$ | Port P1 | Input/output, 6-bit unit | CMOS compatible input level CMOS 3-state output | LCD segment output | PULL register A <br> Segment output enable register | (1) <br> (2) |
| P16, P17 |  | Input/output, individual bits | CMOS compatible input level CMOS 3-state output |  | PULL register A | (4) |
| P20-P27 | Port P2 | Input/output, individual bits | CMOS compatible input level CMOS 3-state output | Key input (key-on wake-up) interrupt input | PULL register A <br> Interrupt control register2 <br> Key input control register |  |
| $\begin{aligned} & \text { P3o/SEG18- } \\ & \text { P37/SEG25 } \end{aligned}$ | Port P3 | Output | CMOS 3-state output | LCD segment output | Segment output enable register <br> P3 output enable register | (3) |
| P40 | Port P4 | Input/output, individual bits | CMOS compatible input level N -channel open-drain output |  |  | (13) |
| $\begin{aligned} & \text { P41/INT1, } \\ & \text { P42/INT2 } \end{aligned}$ |  |  | CMOS compatible input level CMOS 3-state output | External interrupt input | Interrupt edge selection register | (4) |
| P43/¢/TOUT |  |  |  | Timer output $\phi$ output | PULL register B <br> Timer 123 mode register <br> Tout/b output control register | (12) |
| P44/RxD, |  |  |  | Serial I/O1 function I/O | PULL register B <br> Serial I/O1 control register Serial I/O1 status register <br> UART control register | (5) |
| P45/TxD, |  |  |  |  |  | (6) |
| $\mathrm{P} 47 / \overline{\mathrm{SRDY}}$ |  |  |  |  |  | (7) |
|  |  |  |  |  |  | (8) |
| P50/PWMo, P51/PWM1 | Port P5 | Input/output, individual bits | CMOS compatible input level CMOS 3-state output | PWM output | PULL register B PWM control register | (10) |
| $\begin{aligned} & \text { P52/RTPo, } \\ & \text { P53/RTP1 } \end{aligned}$ |  |  |  | Real time port function output | PULL register B Timer X mode register | (9) |
| P54/CNTR0 |  |  |  | Timer X function I/O | PULL register B Timer X mode register | (11) |
| P55/CNTR1 |  |  |  | Timer Y function input | PULL register B Timer Y mode register | (14) |
| P56/DA1 |  |  |  | DA1 output DTMF input | PULL register B D-A control register | (15) |
| $\begin{aligned} & \hline \text { P57/ADT/ } \\ & \text { DA2 } \end{aligned}$ |  |  |  | DA2 output CTCSS output A-D trigger input | PULL register B <br> D-A control register <br> A-D control register | (15) |

Table 8 List of I/O port function (2)

| Pin | Name | Input/Output | I/O Format | Non-Port Function | Related SFRs | Diagram No. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| P60/SIN2/AN0 | Port P6 | Input/ output, individual bits | CMOS compatible input level CMOS 3-state output | A-D conversion input Serial I/O2 function I/O | PULL register B A-D control register Serial I/O2 control register | (17) |
| $\begin{aligned} & \text { P61/Sout2/ } \\ & \text { AN1 } \end{aligned}$ |  |  |  |  |  | (18) |
| $\begin{aligned} & \text { P62/ScLK21/ } \\ & \text { AN2 } \end{aligned}$ |  |  |  |  |  | (19) |
| $\begin{aligned} & \text { P63/ScLK22 / } \\ & \text { AN3 } \end{aligned}$ |  |  |  |  |  | (20) |
| $\begin{aligned} & \text { P64/AN4- } \\ & \text { P67/AN7 } \end{aligned}$ |  |  |  | A-D conversion input | A-D control register PULL register B | (16) |
| P70/INT0 | Port P7 | Input | CMOS compatible input level | External interrupt input | Interrupt edge selection register | (23) |
| P71-P77 |  | Input/ output, individual bits | CMOS compatible input level <br> N-channel open-drain output |  |  | (13) |
| COM0-COM3 | Common | Output | LCD common output |  | LCD mode register | (21) |
| SEG0-SEG17 | Segment | Output | LCD segment output |  |  | (22) |

Notes1: How to use double-function ports as function I/O ports, refer to the applicable sections.
2: Make sure that the input level at each pin is either 0 V or Vcc during execution of the STP instruction. When an input level is at an intermediate potential, a current will flow Vcc to Vss through the input-stage gate.
(1) Ports $\mathrm{P} 01-\mathrm{P} 07, \mathrm{P} 11-\mathrm{P} 15$

(2) Ports P00, P10

(3) Port P3


(5) Port P44


Fig. 13 Port block diagram (1)
(6) Port P45
(7) Port P46

Serial I/O1 synchronization

clock selection bit


Fig. 14 Port block diagram (2)


Fig. 15 Port block diagram (3)


Fig. 16 Port block diagram (4)

## INTERRUPTS

Interrupts occur by seventeen sources: seven external, nine internal, and one software.

## Interrupt Control

Each interrupt is controlled by an interrupt request bit, an interrupt enable bit, and the interrupt disable flag except for the software interrupt set by the BRK instruction. An interrupt occurs if the corresponding interrupt request and enable bits are " 1 " and the interrupt disable flag is " 0 ".
Interrupt enable bits can be set or cleared by software.
Interrupt request bits can be cleared by software, but cannot be set by software.
The BRK instruction cannot be disabled with any flag or bit. The I flag disables all interrupts except the BRK instruction interrupt. When several interrupts occur at the same time, the interrupts are received according to priority.

## Interrupt Operation

By acceptance of an interrupt, the following operations are automatically performed:

1. The contents of the program counter and the processor status register are automatically pushed onto the stack.
2. The interrupt disable flag is set and the corresponding interrupt request bit is cleared.
3. The interrupt jump destination address is read from the vector table into the program counter.

Table 9 Interrupt vector addresses and priority

| Interrupt Source | Priority | Vector Addresses (Note 1) |  | Interrupt Request Generating Conditions | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | High | Low |  |  |
| Reset (Note 2) | 1 | FFFD16 | FFFC16 | At reset | Non-maskable |
| INT0 | 2 | FFFB16 | FFFA16 | At detection of either rising or falling edge of INTo input | External interrupt (active edge selectable) |
| INT1 | 3 | FFF916 | FFF816 | At detection of either rising or falling edge of INT1 input | External interrupt (active edge selectable) |
| Serial I/O1 reception | 4 | FFF716 | FFF616 | At completion of serial I/O1 data reception | Valid when serial I/O1 is selected |
| Serial I/O1 transmission | 5 | FFF516 | FFF416 | At completion of serial I/O1 transmit shift or when transmission buffer is empty | Valid when serial I/O1 is selected |
| Timer X | 6 | FFF316 | FFF216 | At timer X underflow |  |
| Timer Y | 7 | FFF116 | FFF016 | At timer Y underflow |  |
| Timer 2 | 8 | FFEF16 | FFEE16 | At timer 2 underflow |  |
| Timer 3 | 9 | FFED16 | FFEC16 | At timer 3 underflow |  |
| CNTR0 | 10 | FFEB16 | FFEA16 | At detection of either rising or falling edge of CNTRo input | External interrupt (active edge selectable) |
| CNTR1 | 11 | FFE916 | FFE816 | At detection of either rising or falling edge of CNTR1 input | External interrupt (active edge selectable) |
| Timer 1 | 12 | FFE716 | FFE616 | At timer 1 underflow |  |
| INT2 | 13 | FFE516 | FFE416 | At detection of either rising or falling edge of INT2 input | External interrupt (active edge selectable) |
| Serial I/O2 | 14 | FFE316 | FFE216 | At completion of serial I/O2 data transmission or reception | Valid when serial I/O2 is selected |
| Key input (Key-on wake-up) | 15 | FFE116 | FFE016 | At falling of conjunction of input level for port P2 (at input mode) | External interrupt (valid at falling) |
| ADT ---------- | 16 | FFDF16 | FFDE16 | At falling edge of ADT input | Valid when ADT interrupt is selecteo External interrupt (valid at falling) |
| A-D conversion |  |  |  | At completion of A-D conversion | Valid when A-D interrupt is selected |
| BRK instruction | 17 | FFDD16 | FFDC16 | At BRK instruction execution | Non-maskable software interrupt |

Notes1: Vector addresses contain interrupt jump destination addresses.
2: Reset function in the same way as an interrupt with the highest priority.

## ■Notes on interrupts

When setting the followings, the interrupt request bit may be set to "1".
-When setting external interrupt active edge
Related register: Interrupt edge selection register (address 3A16)
Timer X mode register (address 2716)
Timer Y mode register (address 2816)
-When switching interrupt sources of an interrupt vector address where two or more interrupt sources are allocated
Related register: Interrupt source selection bit of A-D control regsiter (bit 6 of address 3416)

When not requiring for the interrupt occurrence synchronous with these setting, take the following sequence.
(1)Set the corresponding interrupt enable bit to "0" (disabled).
(2)Set the interrupt edge select bit (polarity switch bit) or the interrupt source select bit to " 1 ".
(3)Set the corresponding interrupt request bit to "0" after 1 or more instructions have been executed
(4)Set the corresponding interrupt enable bit to "1" (enabled).


Fig. 17 Interrupt control


Fig. 18 Structure of interrupt-related registers

## Key Input Interrupt (Key-on Wake Up)

A Key-on wake up interrupt request is generated by applying "L" level voltage to any pin of port P2 that have been set to input mode. In other words, it is generated when AND of input level
goes from " 1 " to "0". An example of using a key input interrupt is shown in Figure 19, where an interrupt request is generated by pressing one of the keys consisted as an active-low key matrix which inputs to ports $\mathrm{P} 20-\mathrm{P} 23$.


Fig. 19 Connection example when using key input control register, key input interrupt and port P2 block diagram

## TIMERS

The 3826 group has five timers: timer X , timer Y , timer 1, timer 2, and timer 3. Timer $X$ and timer $Y$ are 16-bit timers, and timer 1, timer 2, and timer 3 are 8-bit timers.
All timers are down count timers. When the timer reaches " 0016 ", an underflow occurs at the next count pulse and the corresponding timer latch is reloaded into the timer and the count is continued. When a timer underflows, the interrupt request bit corresponding to that timer is set to " 1 ".

Read and write operation on 16-bit timer must be performed for both high- and low-order bytes. When reading a 16-bit timer, read the high-order byte first. When writing to a 16-bit timer, write the low-order byte first. The 16-bit timer cannot perform the correct operation when reading during the write operation, or when writing during the read operation.


Fig. 20 Timer block diagram

## Timer X

Timer X is a 16 -bit timer that can be selected in one of four modes and can be controlled the timer X write and the real time port by setting the timer X mode register.

## (1) Timer mode

The timer counts $f(X I N) / 16$ (or $f(X C I N) / 16$ in low-speed mode).

## (2) Pulse output mode

Each time the timer underflows, a signal output from the CNTRo pin is inverted. Except for this, the operation in pulse output mode is the same as in timer mode. When using a timer in this mode, set the corresponding port P54 direction register to output mode.

## (3) Event counter mode

The timer counts signals input through the CNTRo pin.
Except for this, the operation in event counter mode is the same as in timer mode. When using a timer in this mode, set the corresponding port P54 direction register to input mode.

## (4) Pulse width measurement mode

The count source is $f(X I N) / 16$ (or $f(X C I N) / 16$ in low-speed mode). If CNTRo active edge switch bit is " 0 ", the timer counts while the input signal of CNTRo pin is at " H ". If it is " 1 ", the timer counts while the input signal of CNTRo pin is at "L". When using a timer in this mode, set the corresponding port P54 direction register to input mode.

## -Timer X Write Control

If the timer $X$ write control bit is " 0 ", when the value is written in the address of timer X , the value is loaded in the timer X and the latch at the same time.
If the timer X write control bit is " 1 ", when the value is written in the address of timer X , the value is loaded only in the latch. The value in the latch is loaded in timer X after timer X underflows.
If the value is written in latch only, unexpected value may be set in the high-order counter when the writing in high-order latch and the underflow of timer $X$ are performed at the same timing.

## - Real Time Port Control

While the real time port function is valid, data for the real time port are output from ports P52 and P53 each time the timer X underflows. (However, if the real time port control bit is changed from " 0 " to " 1 " after set of the real time port data, data are output independent of the timer X operation.) If the data for the real time port is changed while the real time port function is valid, the changed data are output at the next underflow of timer X . Before using this function, set the corresponding port direction registers to output mode.

## -Note on CNTRo interrupt active edge selection

CNTRo interrupt active edge depends on the CNTRo active edge switch bit.


Fig. 21 Structure of timer X mode register

## Timer Y

Timer Y is a 16-bit timer that can be selected in one of four modes.

## (1) Timer mode

The timer counts $f(X I N) / 16$ (or $f(X C I N) / 16$ in low-speed mode).

## (2) Period measurement mode

CNTR1 interrupt request is generated at rising/falling edge of CNTR1 pin input signal. Simultaneously, the value in timer $Y$ latch is reloaded in timer Y and timer Y continues counting down. Except for the above-mentioned, the operation in period measurement mode is the same as in timer mode.
The timer value just before the reloading at rising/falling of CNTR1 pin input signal is retained until the timer Y is read once after the reload.
The rising/falling timing of CNTR1 pin input signal is found by CNTR1 interrupt. When using a timer in this mode, set the corresponding port P55 direction register to input mode.

## (3) Event counter mode

The timer counts signals input through the CNTR1 pin
Except for this, the operation in event counter mode is the same as in timer mode. When using a timer in this mode, set the corresponding port P55 direction register to input mode.

## (4) Pulse width HL continuously measurement mode

CNTR1 interrupt request is generated at both rising and falling edges of CNTR1 pin input signal. Except for this, the operation in pulse width HL continuously measurement mode is the same as in period measurement mode. When using a timer in this mode, set the corresponding port P55 direction register to input mode.

## ■Note on CNTR1 interrupt active edge selection

CNTR1 interrupt active edge depends on the CNTR1 active edge switch bit. However, in pulse width HL continuously measurement mode, CNTR1 interrupt request is generated at both rising and falling edges of CNTR1 pin input signal regardless of the setting of CNTR1 active edge switch bit.


Fig. 22 Structure of timer Y mode register

## Timer 1, Timer 2, Timer 3

Timer 1, timer 2, and timer 3 are 8 -bit timers. The count source for each timer can be selected by timer 123 mode register. The timer latch value is not affected by a change of the count source. However, because changing the count source may cause an inadvertent count down of the timer. Therefore, rewrite the value of timer whenever the count source is changed.

## -Timer 2 Write Control

If the timer 2 write control bit is " 0 ", when the value is written in the address of timer 2, the value is loaded in the timer 2 and the latch at the same time.
If the timer 2 write control bit is " 1 ", when the value is written in the address of timer 2 , the value is loaded only in the latch. The value in the latch is loaded in timer 2 after timer 2 underflows.

## - Timer 2 Output Control

When the timer 2 (TOUT) is output enabled, an inversion signal from pin TOUT is output each time timer 2 underflows. In this case, set the port P56 shared with the port TOUT to the output mode.

## ■Note on Timer 1 to Timer 3

When the count source of timers 1 to 3 is changed, the timer counting value may be changed large because a thin pulse is generated in count input of timer. If timer 1 output is selected as the count source of timer 2 or timer 3 , when timer 1 is written, the counting value of timer 2 or timer 3 may be changed large because a thin pulse is generated in timer 1 output.
Therefore, set the value of timer in the order of timer 1, timer 2 and timer 3 after the count source selection of timer 1 to 3 .


Fig. 23 Structure of timer 123 mode register

## SERIAL I/O <br> Serial I/O1

Serial I/O1 can be used as either clock synchronous or asynchronous (UART) serial I/O. A dedicated timer (baud rate generator) is also provided for baud rate generation.

## (1) Clock Synchronous Serial I/O Mode

Clock synchronous serial I/O mode can be selected by setting the mode selection bit of the serial I/O1 control register to "1".
For clock synchronous serial I/O1, the transmitter and the receiver must use the same clock. If an internal clock is used, transfer is started by a write signal to the TB/RB (address 001816).


Fig. 24 Block diagram of clock synchronous serial I/O1


Fig. 25 Operation of clock synchronous serial I/O1 function

## (2) Asynchronous Serial I/O (UART) Mode

Clock asynchronous serial I/O mode (UART) can be selected by clearing the serial I/O mode selection bit of the serial I/O1 control register to " 0 ".
Eight serial data transfer formats can be selected, and the transfer formats used by a transmitter and receiver must be identical.
The transmit and receive shift registers each have a buffer regis-
ter, but the two buffers have the same address in memory. Since the shift register cannot be written to or read from directly, transmit data is written to the transmit buffer, and receive data is read from the receive buffer.
The transmit buffer can also hold the next data to be transmitted, and the receive buffer register can hold a character while the next character is being received.


Fig. 26 Block diagram of UART serial I/O1


Fig. 27 Operation of UART serial I/O1 function

## [Transmit Buffer/Receive Buffer Register (TB/ RB)] 001816

The transmit buffer register and the receive buffer register are located at the same address. The transmit buffer register is writeonly and the receive buffer register is read-only. If a character bit length is 7 bits, the MSB of data stored in the receive buffer register is " 0 ".

## [Serial I/O1 Status Register (SIO1STS)] 001916

The read-only serial I/O1 status register consists of seven flags (bits 0 to 6 ) which indicate the operating status of the serial $\mathrm{I} / \mathrm{O} 1$ function and various errors.
Three of the flags (bits 4 to 6 ) are valid only in UART mode.
The receive buffer full flag (bit 1 ) is cleared to " 0 " when the receive buffer is read.
If there is an error, it is detected at the same time that data is transferred from the receive shift register to the receive buffer register, and the receive buffer full flag is set. A write to the serial I/O1 status register clears all the error flags OE, PE, FE, and SE (bit 3 to bit 6, respectively). Writing " 0 " to the serial I/O1 enable bit SIOE (bit 7 of the Serial I/O1 Control Register) also clears all the status flags, including the error flags.
All bits of the serial I/O1 status register are initialized to "0" at reset, but if the transmit enable bit (bit 4) of the serial I/O1 control register has been set to " 1 ", the transmit shift register shift completion flag (bit 2) and the transmit buffer empty flag (bit 0) become "1".

## [Serial I/O1 Control Register (SIO1CON)] 001A16

The serial I/O1 control register contains eight control bits for the serial I/O1 function.

## [UART Control Register (UARTCON)] 001B16

The UART control register consists of four control bits (bits 0 to 3 ) which are valid when asynchronous serial I/O is selected and set the data format of an data transfer. One bit in this register (bit 4) is always valid and sets the output structure of the $\mathrm{P} 45 / \mathrm{TxD}$ pin.

## [Baud Rate Generator (BRG)] 001C16

The baud rate generator determines the baud rate for serial transfer.
The baud rate generator divides the frequency of the count source by $1 /(n+1)$, where $n$ is the value written to the baud rate generator.

## ■Notes on serial I/O

When setting the transmit enable bit to " 1 ", the serial I/O1 transmit interrupt request bit is automatically set to " 1 ". When not requiring the interrupt occurrence synchronous with the transmission enalbed, take the following sequence.
(1)Set the serial I/O1 transmit interrupt enable bit to "0" (disabled). (2)Set the transmit enable bit to " 1 ".
(3) Set the serial I/O1 transmit interrupt request bit to " 0 " after 1 or more instructions have been executed.
(4)Set the serial I/O1 transmit interrupt enable bit to "1" (enabled).



UART control register UARTCON : address 001B16

- Character length selection bit (CHAS)

0: 8 bits
1:7 bits
Parity enable bit (PARE)
0 : Parity checking disabled
1: Parity checking enabled
Parity selection bit (PARS)
0 : Even parity
1: Odd parity
Stop bit length selection bit (STPS)
$0: 1$ stop bit
1:2 stop bits
P45/TxD P-channel output disable bit (POFF)
0 : CMOS output (in output mode)
1: N -channel open-drain output (in output mode)
Not used (return "1" when read)

Fig. 28 Structure of serial I/O1 control registers

## Serial I/O2

The serial I/O2 function can be used only for clock synchronous serial I/O.
For clock synchronous serial I/O2, the transmitter and the receiver must use the same clock. When the internal clock is used, transfer is started by a write signal to the serial I/O2 register.
When an internal clock is selected as the synchronous clock of the serial I/O2, either P62 or P63 can be selected as an output pin of the synchronous clock. In this case, the pin that is not selected as an output pin of the synchronous clock functions as a port.
[Serial I/O2 Control Register (SIO2CON)] 001D16
The serial I/O2 control register contains 8 bits which control various serial I/O2 functions.


Fig. 29 Structure of serial I/O2 control register


Fig. 30 Block diagram of serial I/O2 function


Notes 1: When the internal clock is selected as the transfer clock, the divide ratio can be selected by setting bits 0 to 2 of the serial l/O2 control register
2: When the internal clock is selected as the transfer clock, the S out2 pin goes to high impedance after transfer completion When the external clock is selected as the transfer clock, a content of the serial I/O shift register is continued to shift during inputting a transfer clock. The Sout2 pin does not go to high impedance after transfer completion.

Fig. 31 Timing of serial I/O2 function

## PULSE WIDTH MODULATION (PWM)

The 3826 group has a PWM function with an 8 -bit resolution, based on a signal that is the clock input XIN or that clock input divided by 2 .

## Data Setting

The PWM output pin also functions as ports P50 and P51. Set the PWM period by the PWM prescaler, and set the period during which the output pulse is an " H " by the PWM register.
If PWM count source is $f($ XIN $)$ and the value in the PWM prescaler is $n$ and the value in the PWM register is $m$ (where $n=0$ to 255 and $m=0$ to 255) :
PWM period $=255 \times(n+1) / f(X I N)$

$$
=31.875 \times(n+1) \mu \mathrm{s}(\text { when } f(X I N)=8 M H z)
$$

Output pulse "H" period $=P W M$ period $\times \mathrm{m} / 255$

$$
\begin{aligned}
= & 0.125 \times(n+1) \times m \mu \mathrm{~s} \\
& (\text { when } f(\mathrm{XIN})=8 \mathrm{MHz})
\end{aligned}
$$

## PWM Operation

When at least either bit 1 (PWMo function enable bit) or bit 2 (PWM1 function enable bit) of the PWM control register is set to "1", operation starts by initializing the PWM output circuit, and pulses are output starting at an "H". When one PWM output is enabled and that the other PWM output is enabled, PWM output which is enabled to output later starts pulse output from halfway. When the PWM register or PWM prescaler is updated during PWM output, the pulses will change in the cycle after the one in which the change was made.


Fig. 32 Timing of PWM cycle


Fig. 33 Block diagram of PWM function


Fig. 34 Structure of PWM control register


Fig. 35 PWM output timing when PWM register or PWM prescaler is changed

## A-D CONVERTER

The functional blocks of the A-D converter are described below.

## [A-D Conversion Register (AD)] 003516

The A-D conversion register is a read-only register that contains the result of an A-D conversion. When reading this register during an A-D conversion, the previous conversion result is read.

## [A-D Control Register (ADCON)] 003416

The A-D control register controls the A-D conversion process. Bits 0 to 2 of this register select specific analog input pins. Bit 3 signals the completion of an A-D conversion. The value of this bit remains at " 0 " during an A-D conversion, then changes to " 1 " when the $A-$ $D$ conversion is completed. Writing " 0 " to this bit starts the A-D conversion. Bit 4 controls the transistor which breaks the through current of the resistor ladder. When bit 5, which is the AD external trigger valid bit, is set to " 1 ", this bit enables A-D conversion even by a falling edge of an ADT input. Set ports which share with ADT pins to input when using an A-D external trigger.

## Comparison Voltage Generator

The comparison voltage generator divides the voltage between AVSS and VREF by 256, and outputs the divided voltages.

## Channel Selector

The channel selector selects one of the input ports P67/AN7-P60/ ANo.

## Comparator and Control Circuit

The comparator and control circuit compare an analog input voltage with the comparison voltage and store the result in the A-D conversion register. When an A-D conversion is completed, the control circuit sets the AD conversion completion bit and the AD interrupt request bit to "1".
Note that the comparator is constructed linked to a capacitor, so set $f($ XIN $)$ to at least 500 kHz during A-D conversion.
Use the clock divided from the main clock XIN as the internal clock $\phi$.


Fig. 36 Structure of A-D control register


Fig. 37 A-D converter block diagram

## D-A Converter

The 3826 group has an on-chip D-A converter with 8-bit resolution and 2 channels (DAi $(i=1,2))$. After the DTMF/DA1 selection bit or CTCSS/DA2 selection bit is set to " 0 ", the $D-A$ converter is performed by setting the value in the D-A conversion register. The result of D-A converter is output from DAi pin by setting the DTMF/ DA1 output enable bit or CTCSS/DA2 output enable bit to "1". When using the D-A converter, the corresponding port direction register bit (P56/DA1, P57/DA2) should be set to "0" (input status) and the pull-up resistor should be in the OFF state.
The output analog voltage V is determined by the value n (base 10) in the D-A conversion register as follows:

V=VREF $\times n / 256$ ( $n=0$ to 255 )
Where VREF is the reference voltage

At reset, the D-A conversion registers are cleared to "0016", the DTMF/DA1 output enable bit or CTCSS/DA2 output enable bit are cleared to " 0 ", and DAi pin goes to high impedance state. The DA output is not buffered, so connect an external buffer when driving a low-impedance load.

## - Note on applied voltage to Vref pin

When the P56/DA1 pin and P57/DA2 pin are used as I/O ports, be sure to apply Vcc level to Vref pin.
When these pins are used as D-A conversion output pins, the Vcc level is recommended for the applied voltage to Vref pin.
When the voltage below Vcc level is applied, the D-A conversion accuracy may be worse.


Fig. 38 Structure of D-A control register


Fig. 39 Block diagram of D-A converter

## DTMF Function (Dual Tone Multi Frequency)

DTMF function is used to output the result which generated automatically the waveform of sine wave of two kinds of different frequency, and added two kinds of this sine wave as an analog value.
DTMF output can be performed using DA1 function. DTMF waveform is output by setting " 1 " to the DTMF/DA1 output enable bit (bit 0 of address 003616), and setting " 1 " to the DTMF/DA1 selection bit (bit 2 of address 003616). At this time, set "0" (input state) to the direction register of ports P56/DA1 and pull-up resistor to be OFF state.
In order to set two kinds of frequency which generates DTMF waveform, value is written in the DTMF high group timer and the DTMF low group timer, respectively. By the value $n$ written in the above-mentioned timer, respectively, the sine wave of the following frequency can be generated.

$$
f=\frac{f(X I N) / 2}{(n+1) \times 32}(H z)
$$

Set "0616" or more to the DTMF high group timer and the DTMF low group timer. After reset release, " 0616 " is automatically set to them.

The digital value for one period of high group and low group output is shown in Figure 40.
DTMF output is automatically input to high-order 6 bits of the D-A1 conversion register as 6-bit D-A data. The low-order 2 bits of the D-A1 conversion register are fixed to the value written in the D-A1 conversion register.
Moreover, only the sine wave of high group can be output by setting " 1 " to the bit 4 of the D-A control register. By setting " 1 " to the bit 5 of the D-A control register similarly, only the sine wave of low group can be output. Writing to the DTMF high group timer and the DTMF low group timer can also be changed to "writing to latch and timer simultaneously" by setting " 1 " to the bit 6 of the D-A control register. "Writing to only latch" is set after reset release. If the D-A1 conversion register is read when the DTMF function is selected, the digital value of DTMF output can be read.


* This is the value set to D-A1 conversion register when the low-order 2 bits are " 0 ".

Fig. 40 Waveform data of high group and low group

Low Groupt Frequency, High Group Frequency
Low group frequency and high group frequency are as follows. Table 10 shows the example of frequency accuracy (at $f($ XIN $)=4$ MHz ).
(1) Low group frequency

- 697 Hz
- 770 Hz
- 852 Hz
- 941 Hz
(2) High group frequency
- 1209 Hz
- 1336 Hz
- 1477 Hz
- 1633 Hz


Fig. 41 Key matrix of telephone and rating frequency

Table 10 Example of frequency accuracy (at $\mathrm{f}(\mathrm{XiN})=\mathbf{4} \mathrm{MHz}$ )

| Rating frequency $(\mathrm{Hz})$ | n (Timer value) | Output frequency $(\mathrm{Hz})]$ | Error frequency $(\mathrm{Hz})$ | Deviation $(\%)$ |
| :---: | :---: | :---: | :---: | :---: |
| 697 | 89 | 694.4 | -2.6 | -0.367 |
| 770 | 80 | 771.6 | 856.2 | 1.6 |
|  | 72 | 946.9 | 4.2 | 0.208 |
| 852 | 65 | 1201.9 | 5.9 | 0.630 |
| 941 | 51 | 1329.7 | -7.1 | -0.580 |
| 1209 | 46 | 1488.1 | -6.3 | -0.460 |
| 1336 | 41 | 1644.7 | 11.1 | 0.750 |
| 1477 | 37 | 72 | 11.7 | 0.720 |

## CTCSS Function <br> (Continuous Tone-Controlled Squelch System)

The CTCSS function is used to generate the sine wave of single frequency automatically. The CTCSS output waveform can be output using DA2 function. CTCSS waveform is outputted by setting "1" to the CTCSS/DA2 output enable bit (bit 1 of address 003616), and setting " 1 " to the CTCSS/DA2 selection bit (bit 3 of address 003616). In order to set the frequency of CTCSS output, value is written in the CTCSS timer. The CTCSS timer consists of a 10-bit timer. When writing a value to the CTCSS timer, write the low-order byte first.

When reading a value from the CTCSS timer, read the high-order byte first. By the value $n$ written in the CTCSS timer, the sine wave of the following frequency is generated.
$f=\frac{f(X I N) / 2}{(n+1) \times 64}(H z)$

Set "00616" or more to the CTCSS timer. " 0016 " is automatically set to the high-order of the CTCSS timer and "0616" is automatically set to the low-order of the CTCSS timer after reset release The amplitude of CTCSS output is obtained by the following formula.
$C=\frac{\mathrm{VcC}}{2}$

If the D-A2 conversion register is read when the CTCSS function is selected, the digital value of CTCSS output can be read.

Table 11 Example of frequency accuracy (at $f(X I N)=4 \mathrm{MHz}$ )

| Rating frequency $(\mathrm{Hz})$ | n (Timer value) | Output frequency (Hz)] | Error frequency (Hz) | Deviation (\%) |
| :---: | :---: | :---: | :---: | :---: |
| 67.0 | 465 | 67.06 | 0.06 | 0.089 |
| 77.0 | 405 | 76.97 | -0.03 | -0.038 |
| 88.5 | 352 | 88.53 | 0.027 | 0.030 |
| 100.0 | 312 | 99.84 | -0.16 | -0.160 |
| 107.2 | 291 | 107.02 | -0.18 | -0.167 |
| 114.8 | 271 | 114.89 | 0.09 | 0.078 |
| 123.0 | 253 | 123.03 | 0.03 | 0.026 |
| 131.8 | 236 | 131.86 | 0.06 | 0.043 |
| 141.3 | 220 | 141.40 | 0.10 | 0.073 |
| 151.4 | 192 | 151.70 | 0.30 | 0.198 |
| 162.2 | 179 | 161.92 | -0.28 | -0.174 |
| 173.8 | 167 | 173.61 | -0.19 | -0.109 |
| 186.2 | 153 | 202.92 | -0.19 | -0.101 |
| 203.5 | 142 | 218.53 | -0.58 | -0.284 |
| 218.1 | 124 | 233.20 | 0.43 | 0.198 |
| 233.6 |  | -0.39 | -0.167 |  |
| 250.3 |  |  | -0.30 | -0.120 |

## LCD DRIVE CONTROL CIRCUIT

The 3826 group has the built-in Liquid Crystal Display (LCD) drive control circuit consisting of the following.

- LCD display RAM
- Segment output enable register
- LCD mode register
- Voltage multiplier
- Selector
- Timing controller
- Common driver
- Segment driver
- Bias control circuit

A maximum of 40 segment output pins and 4 common output pins can be used.
Up to 160 pixels can be controlled for LCD display. When the LCD
enable bit is set to " 1 " after data is set in the LCD mode register, the segment output enable register and the LCD display RAM, the LCD drive control circuit starts reading the display data automatically, performs the bias control and the duty ratio control, and displays the data on the LCD panel.

Table 12. Maximum number of display pixels at each duty ratio

| Duty ratio | Maximum number of display pixel |
| :---: | :--- |
| 2 | 80 dots <br> or 8 segment LCD 10 digits |
| 3 | 120 dots <br> or 8 segment LCD 15 digits |
| 4 | 160 dots <br> or 8 segment LCD 20 digits |



LCD mode register (LM : address 003916)

Duty ratio selection bits
00 : Not used
$01: 2$ duty (use COM0, COM 1 1)
$10: 3$ duty (use COM0-COM2)
$11: 4$ duty (use $\mathrm{COM}_{0}-\mathrm{COM}_{3}$ )
Bias control b
$0: 1 / 3$ bias
1:1/2 bias
LCD enable bit
0 : LCD OFF
1:LCD ON
Voltage multiplier control bit
0 : Voltage multiplier disable
1 : Voltage multiplier enable
LCD circuit divider division ratio selection bits
00 : Clock input
$01: 2$ division of Clock input
$10: 4$ division of Clock input
11:8 division of Clock input
LCDCK count source selection bit (Note)
0 : f(XCIN)/32
1: $\mathrm{f}(\mathrm{XIN}) / 8192\left(\mathrm{f}\left(\mathrm{XCIN}_{\mathrm{CIN}}\right) / 8192\right.$ in low-speed mode)
Note : LCDCK is a clock for a LCD timing controller.

Fig. 42 Structure of segment output enable register and LCD mode register


Fig. 43 Block diagram of LCD controller/driver

## Voltage Multiplier (3 Times)

The voltage multiplier performs threefold boosting. This circuit inputs a reference voltage for boosting from LCD power input pin VL1. (However, when using a $1 / 2$ bias, connect VL1 and VL2 and apply voltage by external resistor division.)
Set each bit of the segment output enable register and the LCD mode register in the following order for operating the voltage multiplier.

1. Set the segment output enable bits (bits 0 to 5 ) of the segment output enable register to " 0 " or " 1 ."
2. Set the duty ratio selection bits (bits 0 and 1), the bias control bit (bit 2), the LCD circuit divider division ratio selection bits (bits 5 and 6), and the LCDCK count source selection bit (bit 7) of the LCD mode register to " 0 " or " 1 ."
3. Set the LCD output enable bit (bit 6) of the segment output enable register to " 1. ."
4. Set the voltage multiplier control bit (bit 4) of the LCD mode register to "1."
When voltage is input to the VL1 pin during operating the voltage multiplier, voltage that is twice as large as VL1 occurs at the VL2 pin, and voltage that is three times as large as VL1 occurs at the VL3 pin.
When using the voltage multiplier, apply $1.3 \mathrm{~V} \leq$ Voltage $\leq 2.3 \mathrm{~V}$ (1.3 V $\leq$ Voltage $\leq 2.1 \mathrm{~V}$ for low voltage version) to the VL1 pin.

When not using the voltage multiplier,apply proper voltage to the LCD power input pins (VL1-VL3). Then set the LCD output enable bit to "1."
When the LCD output enable bit is set to " 0 ," the VCC voltage is applied to the VL3 pin inside of this microcomputer.
The voltage multiplier control bit (bit 4 of the LCD mode register) controls the voltage multiplier.

## Bias Control and Applied Voltage to LCD Power Input Pins

To the LCD power input pins (VL1-VL3), apply the voltage shown in Table 13 according to the bias value.
Select a bias value by the bias control bit (bit 2 of the LCD mode register).

Table 13. Bias control and applied voltage to VL1-VL3

| Bias value | Voltage value |
| :---: | :--- |
| $1 / 3$ bias | VL3 $=\mathrm{VLCD}$ <br>  <br>  <br>  <br>  <br> VL2 $=2 / 3 \mathrm{VLCD}$ <br> $\mathrm{VL1}=1 / 3 \mathrm{VLCD}$ |
|  | $\mathrm{VL3}=\mathrm{VLCD}$ <br> $\mathrm{VL2}=\mathrm{VL1}=1 / 2 \mathrm{VLCD}$ |

Note : VLCD is the maximum value of supplied voltage for the LCD panel.


Fig. 44 Example of circuit at each bias

## Common Pin and Duty Ratio Control

The common pins (СОМо-COM3) to be used are determined by duty ratio.
Select duty ratio by the duty ratio selection bits (bits 0 and 1 of the LCD mode register).
When releasing from reset, the Vcc (VL3) voltage is output from the common pins.

Table 14. Duty ratio control and common pins used

| Duty <br> ratio | Duty ratio selection bits |  | Common pins used |
| :---: | :---: | :---: | :--- |
|  | Bit 1 | Bit 0 |  |
| 2 | 0 | 1 | $\mathrm{COM} 0, \mathrm{COM} 1$ (Note 1) |
| 3 | 1 | 0 | $\mathrm{COM} 0-\mathrm{COM} 2$ (Note 2) |
| 4 | 1 | 1 | $\mathrm{COM} 0-\mathrm{COM} 3$ |

Notes 1: COM 2 and COM 3 are open.
2: COM 3 is open.

## Segment Signal Output Pin

Segment signal output pins are classified into the segment-only pins (SEG0-SEG17), the segment/output port pins (SEG18SEG25), and the segment///O port pins (SEG26-SEG39).
Segment signals are output according to the bit data of the LCD RAM corresponding to the duty ratio. After reset release, a Vcc (=VL3) voltage is output to the segment-only pins and the segment/output port pins are the high impedance condition and pulled up to Vcc (=VL3) voltage.
Also, the segment///O port pins(SEG26-SEG39) are set to input ports, and Vcc (=VL3) is applied to them by pull-up resistor.

## LCD Display RAM

Address 004016 to 005316 is the designated RAM for the LCD display. When " 1 " are written to these addresses, the corresponding segments of the LCD display panel are turned on.

## LCD Drive Timing

The LCDCK timing frequency (LCD drive timing) is generated internally and the frame frequency can be determined with the following equation;
$f($ LCDCK $)=\frac{\text { (frequency of count source for LCDCK) }}{\text { (divider division ratio for LCD) }}$
Frame frequency $=\frac{f(\text { LCDCK })}{\text { duty ratio }}$


Fig. 45 LCD display RAM map


Fig. 46 LCD drive waveform (1/2 bias)


Fig. 47 LCD drive waveform (1/3 bias)

## Watchdog Timer

The watchdog timer gives a mean of returning to the reset status when a program cannot run on a normal loop (for example, because of a software runaway).
The watchdog timer consists of an 8-bit watchdog timer L and a 6bit watchdog timer H . At reset or writing to the watchdog timer control register (address 003716), the watchdog timer is set to "3FFF16." When any data is not written to the watchdog timer control register (address 003716) after reset, the watchdog timer is in stop state. The watchdog timer starts to count down from "3FFF16" by writing an optional value into the watchdog timer control register (address 003716) and an internal reset occurs at an underflow. Accordingly, programming is usually performed so that writing to the watchdog timer control register (address 003716) may be started before an underflow. The watchdog timer does not function when an optional value has not been written to the watchdog timer control register (address 003716). When address 003716 is read, the following values are read:

- value of high-order 6-bit counter
- value of STP instruction disable bit
- value of count source selection bit.

When bit 6 of the watchdog timer control register (address 003716) is set to " 0 ," the STP instruction is valid. The STP instruction is disabled by rewriting this bit to "1." At this time, if the STP instruction is executed, it is processed as an undefined instruction, so that a reset occurs inside.
This bit cannot be rewritten to " 0 " by programming. This bit is " 0 " immediately after reset.
The count source of the watchdog timer becomes the system clock $\phi$ divided by 8 . The detection time in this case is set to 8.19 s at $\mathrm{f}(\mathrm{XCIN})=32 \mathrm{kHz}$ and 32.768 ms at $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$.
However, count source of high-order 6-bit timer can be connected to a signal divided system clock by 8 directly by writing the bit 7 of the watchdog timer control register (address 003716) to "1." The detection time in this case is set to 32 ms at $\mathrm{f}(\mathrm{XCIN})=32 \mathrm{kHz}$ and $128 \mu \mathrm{~s}$ at $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$. There is no difference in the detection time between the middle-speed mode and the high-speed mode.


Note: This is the bit 7 of CPU mode register and is used to switch the middle-/high-speed mode and low-speed mode.
Fig. 48 Block diagram of watchdog timer


Fig. 49 Structure of watchdog timer control register


Fig. 50 Timing of reset output

## Tout/ф CLOCK OUTPUT FUNCTION

The internal system clock $\phi$ or timer 2 divided by 2 (Tout output) can be output from port P43 by setting the Tout/ $\phi$ output control bit (bit 1) of the timer 123 mode register and the TOUT/ $\phi$ output control register. Set bit 3 of the port P4 direction register to " 1 " when outputting the clock.


Tout/b output control register
(CKOUT : address 002A ${ }_{16}$ )
Tout/ф output control bit
0 : $\phi$ clock output
1 : Tout output
Not used (return " 0 " when read)


Timer 123 mode register (T123M : address 002916)

Tout output active edge switch bit
0 : Start at "H" output
1 : Start at " L " output
Tout/ $\phi$ output control bit
0 : Tout/ф output disabled
1 : Tout/ф output enabled
Timer 2 write control bit
0 : Write data in latch and timer 1: Write data in latch only
Timer 2 count source selection bit
0 : Timer 1 output
1 : $\mathrm{f}(\mathrm{Xin}) / 16$
(or f(Xcin)/16 in low-speed mode*)
Timer 3 count source selection bit
0 : Timer 1 output
1 : $\mathrm{f}(\mathrm{XIN}) / 16$
(or $\mathrm{f}(\mathrm{XCIN}) / 16$ in low-speed mode*)
Timer 1 count source selection bit
$0: f(X i n) / 16$
(or $\mathrm{f}\left(\mathrm{X}_{\mathrm{cIN}}\right) / 16$ in low-speed mode*)
1 : f(XCIN)
Not used (return " 0 " when read)

* : Internal clock $\phi$ is $f\left(\mathrm{X}_{\mathrm{CIN}}\right) / 2$ in the low-speed mode.

Fig. 51 Structure of TOUT/ $\phi$ output-related register

## RESET CIRCUIT

To reset the microcomputer, $\overline{R E S E T}$ pin should be held at an "L" level for $2 \mu \mathrm{~s}$ or more. Then the RESET pin is returned to an "H" level (the power source voltage should be between Vcc(min.) and 5.5 V , and the quartz-crystal oscillator should be stable), reset is released. After the reset is completed, the program starts from the address contained in address FFFD16 (high-order byte) and address FFFC16 (low-order byte). Make sure that the reset input voltage is less than 0.2 Vcc for Vcc of Vcc (min.).


Fig. 52 Example of reset circuit


Fig. 53 Reset Sequence


Fig. 54 Internal state of microcomputer immediately after reset

## CLOCK GENERATING CIRCUIT

The 3826 group has two built-in oscillation circuits. An oscillation circuit can be formed by connecting a resonator between XIN and Xout (XcIN and XcOUT). Use the circuit constants in accordance with the resonator manufacturer's recommended values. No external resistor is needed between XIN and XOUT since a feed-back resistor exists on-chip. However, an external feed-back resistor is needed between XCIN and Xcout.
To supply a clock signal externally, input it to the XIN pin and make the Xout pin open. The sub-clock XCIN-Xcout oscillation circuit cannot directly input clocks that are externally generated. Accordingly, be sure to cause an external resonator to oscillate. Immediately after poweron, only the XIN oscillation circuit starts oscillating, and XCIN and XCOUT pins go to high-impedance state.

## Frequency Control

## (1) Middle-speed mode

The internal clock $\phi$ is the frequency of XIN divided by 8.
After reset, this mode is selected.

## (2)High-speed mode

The internal clock $\phi$ is half the frequency of XIN.

## (3) Low-speed mode

- The internal clock $\phi$ is half the frequency of Xcin.
- A low-power consumption operation can be realized by stopping the main clock XIN in this mode. To stop the main clock, set bit 5 of the CPU mode register to " 1 ".
When the main clock XIN is restarted, set enough time for oscillation to stabilize by programming.
Note: If you switch the mode between middle/high-speed and lowspeed, stabilize both XIN and XCIN oscillations. The sufficient time is required for the sub-clock to stabilize, especially immediately after power-on and at returning from stop mode. When switching the mode between middle/highspeed and low-speed, set the frequency in the condition that $f(X I N)>3 \cdot f(X C I N)$.


## Oscillation Contro

## (1) Stop mode

If the STP instruction is executed, the internal clock $\phi$ stops at an "H" level, and XIN and XCIN oscillators stop.
In this time, values set previously to timer 1 latch and timer 2 latch are loaded automatically to timer 1 and timer 2 . Set the values to generate the wait time required for oscillation stabilization to timer 1 latch and timer 2 latch (low-order 8 bits of timer 1 and high-order 8 bits of timer 2) before the STP instruction.
Either XIN or XCIN divided by 16 is input to timer 1 as count source, and the output of timer 1 is connected to timer 2.
The bits of the timer 123 mode register except bit 4 are cleared to " 0 ". Set the timer 1 and timer 2 interrupt enable bits to disabled ("0") before executing the STP instruction.
Oscillator restarts at reset or when an external interrupt is received, but the internal clock $\phi$ is not supplied to the CPU until timer 2 underflows. This allows time for the clock circuit oscillation to stabilize when a ceramic resonator is used

## (2) Wait mode

If the WIT instruction is executed, the internal clock $\phi$ stops at an "H" level. The states of XIN and XCIN are the same as the state before the executing the WIT instruction. The internal clock restarts at reset or when an interrupt is received. Since the oscillator does not stop, normal operation can be started immediately after the clock is restarted.


Fig. 55 Ceramic resonator circuit


Fig. 56 External clock input circuit


Fig. 57 Clock generating circuit block diagram


M5 : Main clock (Xin-Xout) stop bit
0 : Oscillating
1: Stopped
M6: Main clock division ratio selection bit
0: f(Xin)/2 (high-speed mode)
1: $\mathrm{f}(\mathrm{XIN}) / 8$ (middle-speed mode)
M7 : Internal system clock selection bit
0: Xin-Xout selected (middle-/high-speed mode)
1: XCIN-XCOUT Selected
(low-speed mode)

Notes 1: Switch the mode by the arrows shown between the mode blocks. (Do not switch between the mode directly without an arrow.)
2: The all modes can be switched to the stop mode or the wait mode and returned to the source mode when the stop mode or the wait mode is ended.
3: Timer and LCD operate in the wait mode.
4: When the stop mode is ended, a delay time can be set by timer 1 and timer 2 in middle-/high-speed mode
5: When the stop mode is ended, a delay time in low-speed mode can be set as well.
6: Wait until oscillation stabilizes after oscillating the main clock XIN before the switching from the low-speed mode to middle-/highspeed mode.
7: The example assumes that 8 MHz is being applied to the XIN pin and 32 kHz to the Xcin pin. $\phi$ indicates the internal clock

Fig. 58 State transitions of system clock

## NOTES ON PROGRAMMING <br> Processor Status Register

The contents of the processor status register (PS) after a reset are undefined, except for the interrupt disable flag (I) which is "1". After a reset, initialize flags which affect program execution.
In particular, it is essential to initialize the index $X$ mode $(T)$ and the decimal mode (D) flags because of their effect on calculations.

## Interrupt

The contents of the interrupt request bits do not change immediately after they have been written. After writing to an interrupt request register, execute at least one instruction before performing a BBC or BBS instruction.

## Decimal Calculations

To calculate in decimal notation, set the decimal mode flag (D) to " 1 ", then execute an ADC or SBC instruction. Only the ADC and SBC instructions yield proper decimal results. After executing an ADC or SBC instruction, execute at least one instruction before executing a SEC, CLC, or CLD instruction.

In decimal mode, the values of the negative $(\mathrm{N})$, overflow $(\mathrm{V})$, and zero ( $Z$ ) flags are invalid.

## Timers

If a value $n$ (between 0 and 255) is written to a timer latch, the frequency division ratio is $1 /(n+1)$.

## Multiplication and Division Instructions

The index mode ( $T$ ) and the decimal mode ( $D$ ) flags do not affect the MUL and DIV instruction.
The execution of these instructions does not change the contents of the processor status register.

## Ports

The contents of the port direction registers cannot be read.
The following cannot be used:

- The data transfer instruction (LDA, etc.)
- The operation instruction when the index $X$ mode flag $(T)$ is " 1 "
- The addressing mode which uses the value of a direction register as an index
- The bit-test instruction (BBC or BBS, etc.) to a direction register
- The read-modify-write instruction (ROR, CLB, or SEB, etc.) to a direction register
Use instructions such as LDM and STA, etc., to set the port direction registers.


## Serial I/O

In clock synchronous serial I/O, if the receive side is using an external clock and it is to output the $\overline{\text { SRDY }}$ signal, set the transmit enable bit, the receive enable bit, and the SRDY output enable bit to "1".
Serial I/O1 continues to output the final bit from the TxD pin after transmission is completed.
In serial I/O2, the SOUT2 pin goes to high impedance state after transmission is completed.

## A-D Converter

The comparator uses internal capacitors whose charge will be lost if the clock frequency is too low.
Make sure that $f(X I N)$ is at least 500 kHz during an A-D conversion. Do not execute the STP or WIT instruction during an A-D conversion.

## Instruction Execution Time

The instruction execution time is obtained by multiplying the frequency of the internal clock $\phi$ by the number of cycles needed to execute an instruction.
The number of cycles required to execute an instruction is shown in the list of machine instructions.
The frequency of the internal clock $\phi$ is half of the XIN frequency.

## DATA REQUIRED FOR MASK ORDERS

The following are necessary when ordering a mask ROM production:
1.Mask ROM Order Confirmation Form*
2.Mark Specification Form*
3.Data to be written to ROM, in EPROM form (three identical copies) or one floppy disk.
*For the mask ROM confirmation and the mark specifications, refer to the "Mitsubishi MCU Technical Information" Homepage (http://www.infomicom.maec.co.jp/indexe.htm).

## ROM PROGRAMMING METHOD

The built-in PROM of the blank One Time PROM version and builtin EPROM version can be read or programmed with a generalpurpose PROM programmer using a special programming adapter. Set the address of PROM programmer in the user ROM area.

Table 15. Programming adapter

| Package | Name of Programming Adapter |
| :---: | :---: |
| 100P6Q-A | PCA4738G-100A |
| $100 \mathrm{P} 6 \mathrm{~S}-\mathrm{A}$ | PCA4738F-100A |
| 100 D 0 | PCA4738L-100A |

The PROM of the blank One Time PROM version is not tested or screened in the assembly process and following processes. To ensure proper operation after programming, the procedure shown in Figure 59 is recommended to verify programming.


Caution : The screening temperature is far higher than the storage temperature. Never expose to $150^{\circ} \mathrm{C}$ exceeding 100 hours.

Fig. 59 Programming and testing of One Time PROM version

## ELECTRICAL CHARACTERISTICS

## ABSOLUTE MAXIMUM RATINGS

Table 16 Absolute maximum ratings

| Symbol | Parameter | Conditions | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Vcc | Power source voltage | All voltages are based on Vss. Output transistors are cut off. | -0.3 to 7.0 | V |
| VI | Input voltage $\mathrm{PO} 0-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 20-\mathrm{P} 27$, <br>  $\mathrm{P} 40-\mathrm{P} 47, \mathrm{P} 50-\mathrm{P} 57, \mathrm{P} 60-\mathrm{P} 67$ |  | -0.3 to Vcc +0.3 | V |
| VI | Input voltage P70-P77 |  | -0.3 to Vcc +0.3 | V |
| VI | Input voltage VL1 |  | -0.3 to VL2 | V |
| VI | Input voltage VL2 |  | VL1 to VL3 | V |
| VI | Input voltage VL3 |  | VL2 to 7.0 | V |
| VI | Input voltage $\mathrm{C}_{1}, \mathrm{C}_{2}$ |  | -0.3 to 7.0 | V |
| VI | Input voltage RESET, XIN |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage $\mathrm{C}_{1}$, C 2 |  | -0.3 to 7.0 | V |
| Vo | Output voltage P00-P07, P10-P15, P30-P37 | At output port | -0.3 to Vcc | V |
|  |  | At segment output | -0.3 to VL3 | V |
| Vo |  |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage VL3 |  | -0.3 to 7.0 | V |
| Vo | Output voltage VL2, SEG0-SEG17 |  | -0.3 to VL3 | V |
| Vo | Output voltage XOUT |  | -0.3 to Vcc +0.3 | V |
| Pd | Power dissipation | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 300 | mW |
| Topr | Operating temperature |  | -20 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Tstg | Storage temperature |  | -40 to 125 | ${ }^{\circ} \mathrm{C}$ |

## RECOMMENDED OPERATING CONDITIONS

Table 17 Recommended operating conditions (1) (Vcc $=2.5$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Vcc | Power source voltage | High-speed mode $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ | 4.0 | 5.0 | 5.5 | V |
|  |  | Middle-speed mode $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ | 2.5 | 5.0 | 5.5 |  |
|  |  | Low-speed mode | 2.5 | 5.0 | 5.5 |  |
| Vss | Power source voltage |  |  | 0 |  | V |
| Vref | A-D, D-A conversion reference voltage |  | 2.0 |  | Vcc | V |
| AVss | Analog power source voltage |  |  | 0 |  | V |
| VIA | Analog input voltage AN0-AN7 |  | AVss |  | Vcc | V |

Table 18 Recommended operating conditions (2) (Vcc = 2.5 to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VIH | " H " input voltage | $\begin{aligned} & \text { P00-P07, P10-P17, P40, P43, P45, P47, P50-P53, } \\ & \text { P56, P61, P64-P67, P71-P77 } \end{aligned}$ | 0.7 Vcc |  | Vcc | V |
| VIH | " H " input voltage | $\begin{aligned} & \text { P20-P27, P41, P42, P44, P46, P54, P55, P57, P60, } \\ & \text { P62, P63, P70 } \end{aligned}$ | 0.8 Vcc |  | Vcc | V |
| VIH | "H" input voltage | RESET | 0.8 Vcc |  | Vcc | V |
| VIH | "H" input voltage | XIN | 0.8 Vcc |  | Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17, P40, P43, P45, P47, P50-P53, } \\ & \text { P56, P61, P64-P67, P71-P77 } \end{aligned}$ | 0 |  | 0.3 Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P20-P27, P41, P42, P44, P46, P54, P55, P57, P60, } \\ & \text { P62, P63, P70 } \end{aligned}$ | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | RESET | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | XIN | 0 |  | 0.2 Vcc | V |

Table 19 Recommended operating conditions (3) (Vcc $=2.5$ to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| $\mathrm{\Sigma lOH}$ (peak) | "H" total peak output current | P00-P07, P10-P17, P20-P27, P30-P37 (Note 1) |  |  | -20 | mA |
| $\Sigma \mathrm{IOH}$ (peak) | "H" total peak output current | P41-P47, P50-P57, P60-P67 (Note 1) |  |  | -20 | mA |
| ミlOL(peak) | "L" total peak output current | P00-P07, P10-P17, P20-P27, P30-P37 (Note 1) |  |  | 20 | mA |
| $\Sigma \mathrm{lOL}$ (peak) | "L" total peak output current | P41-P47, P50-P57, P60-P67 (Note 1) |  |  | 20 | mA |
| $\Sigma \mathrm{IOL}$ (peak) | "L" total peak output current | $\mathrm{P} 40, \mathrm{P} 71-\mathrm{P} 77$ (Note 1) |  |  | 80 | mA |
| ElOH(avg) | "H" total average output current | P00-P07, P10-P17, P20-P27, P30-P37 (Note 1) |  |  | -10 | mA |
| $\Sigma \mathrm{IOH}(\mathrm{avg})$ | "H" total average output current | P41-P47, P50-P57, P60-P67 (Note 1) |  |  | -10 | mA |
| ElOL(avg) | "L" total average output current | P00-P07, P10-P17, P20-P27, P30-P37 (Note 1) |  |  | 10 | mA |
| ElOL(avg) | "L" total average output current | P41-P47, P50-P57, P60-P67 (Note 1) |  |  | 10 | mA |
| EloL(avg) | "L" total average output current | $\mathrm{P} 40, \mathrm{P} 71-\mathrm{P} 77$ (Note 1) |  |  | 40 | mA |
| IOH (peak) | "H" peak output current | P00-P07, P10-P15, P30-P37 (Note 2) |  |  | -1.0 | mA |
| IOH (peak) | "H" peak output current | P16, P17, P20-P27, P41-P47, P50-P57, P60-P67 <br> (Note 2) |  |  | -5.0 | mA |
| IOL(peak) | "L" peak output current | P00-P07, P10-P15, P30-P37 (Note 2) |  |  | 5.0 | mA |
| IOL(peak) | "L" peak output current | P16, P17, P20-P27, P41-P47, P50-P57, P60-P67 (Note 2) |  |  | 10 | mA |
| IOL(peak) | "L" peak output current | P40, P71-P77 (Note 2) |  |  | 20 | mA |
| $\mathrm{IOH}(\mathrm{avg})$ | "H" average output current | $\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 15, \mathrm{P} 30-\mathrm{P} 37$ (Note 3) |  |  | -0.5 | mA |
| IOH(avg) | "H" average output current | P16, P17, P20-P27, P41-P47, P50-P57, P60-P67 |  |  | -2.5 | mA |
| IOL(avg) | "L" average output current | P00-P07, P10-P15, P30-P37 (Note 3) |  |  | 2.5 | mA |
| IOL(avg) | "L" average output current | P16, P17, P20-P27, P41-P47, P50-P57, P60-P67 (Note 3) |  |  | 5.0 | mA |
| IOL(avg) | "L" average output current | P40, P71-P77 (Note 3) |  |  | 10 | mA |

Notes1: The total output current is the sum of all the currents flowing through all the applicable ports. The total average current is an average value measured over 100 ms . The total peak current is the peak value of all the currents.
2: The peak output current is the peak current flowing in each port.
3: The average output current is an average value measured over 100 ms .

Table 20 Recommended operating conditions (4) (Vcc = 2.5 to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| f(CNTRo) <br> f(CNTR1) | Input frequency for timers X and Y (duty cycle 50\%) | $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V})$ |  |  | 4.0 | MHz |
|  |  | $(\mathrm{Vcc} \leq 4.0 \mathrm{~V})$ |  |  | $\begin{gathered} (2 \times V c c) \\ -4 \end{gathered}$ | MHz |
| $f(X I N)$ | Main clock input oscillation frequency (Note 1) | High-speed mode $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V})$ |  |  | 8.0 | MHz |
|  |  | High-speed mode $(2.5 \mathrm{~V} \leq \mathrm{Vcc} \leq 4.0 \mathrm{~V})$ |  |  | $\begin{gathered} (4 \times V c c) \\ -8 \end{gathered}$ | MHz |
|  |  | Middle-speed mode |  |  | 8.0 | MHz |
| f(XCIN) | Sub-clock input oscillation frequency (Notes 1, 2) |  |  | 32.768 | 50 | kHz |

Notes1: When the oscillation frequency has a duty cycle of $50 \%$.
2: When using the microcomputer in low-speed mode, make sure that the sub-clock input oscillation frequency on condition that $f(\operatorname{XcIN})<f(X i N) / 3$.

Table 21 Electrical characteristics (1) (Vcc =4.0 to $5.5 \mathrm{~V}, \mathrm{Ta}=\mathbf{- 2 0}$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Voh | "H" output voltage <br> P00-P07, P10-P15, P30-P37 | $\mathrm{IOH}=-1 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\begin{aligned} & \text { IOH }=-0.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ | Vcc-0.8 |  |  | V |
| Voh | "H" output voltage <br> P16, P17, P20-P27, P41-P47, P50-P57, <br> P60-P67 (Note 1) | $\mathrm{IOH}=-5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\mathrm{IOH}=-1.5 \mathrm{~mA}$ | Vcc-0.5 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ | Vcc-0.8 |  |  | V |
| Vol | "L" output voltage <br> P00-P07, P10-P15, P30-P37 | $\mathrm{IOL}=5 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=1.5 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \\ & \hline \end{aligned}$ |  |  | 0.8 | V |
| Vol | "L" output voltage <br> P16, P17, P20-P27, P41-P47, P50-P57, P60-P67 | $\mathrm{IOL}=10 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=3.0 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=2.5 \mathrm{~mA} \\ & \mathrm{Vcc}=2.5 \mathrm{~V} \\ & \hline \end{aligned}$ |  |  | 0.8 | V |
| Vol | "L" output voltage P40, P71-P77 | $\mathrm{IOL}=10 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=5 \mathrm{~mA} \\ & \mathrm{VCC}=2.5 \mathrm{~V} \end{aligned}$ |  |  | 0.3 | V |
| $\mathrm{V}^{+}$- $\mathrm{V}^{\text {T- }}$ | Hysteresis INT0-INT2, ADT, CNTR0, CNTR1, P20-P27 |  |  | 0.5 |  | V |
| $\mathrm{V}_{\text {+ }+ \text { - }} \mathrm{V}_{\text {T- }}$ | Hysteresis ScLK, RxD, SIN2 |  |  | 0.5 |  | V |
| $\mathrm{V}_{+}^{+}$- $\mathrm{V}_{\text {T- }}$ | Hysteresis RESET |  |  | 0.5 |  | V |
| IIH | "H" input current P00-P07, P10-P17, P20-P27, P40-P47, P50-P57, P60-P67, P70-P77 | V I $=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current RESET | $\mathrm{VI}=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current XIN | $\mathrm{V}_{1}=\mathrm{Vcc}$ |  | 4.0 |  | $\mu \mathrm{A}$ |
| IIL | "L" input current$\begin{aligned} & \text { P00-P07,P10-P17, P20-P27,P41-P47, } \\ & \text { P50-P57, P60-P67 } \end{aligned}$ | $\mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "off" |  |  | -5.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -60.0 | -120.0 | -240.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{VCC}=2.5 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -6.0 | -25.0 | -45.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current P40, P70-P77 |  |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current $\overline{\text { RESET }}$ | V I $=\mathrm{V}$ SS |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current XIN | V I $=\mathrm{Vss}$ |  | -4.0 |  | $\mu \mathrm{A}$ |
| ILOAD | Output load current P30-P37 | Vcc $=5.0 \mathrm{~V}$, Vo = Vcc, Pullup ON Output transistors "off" | -60.0 | -120.0 | -240.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=2.5 \mathrm{~V}, \mathrm{Vo}=\mathrm{Vcc}$, Pullup ON Output transistors "off" | -6.0 | -25.0 | -45.0 | $\mu \mathrm{A}$ |
| ILEAK | Output leak current P30-P37 | Vo = Vcc, Pullup OFF Output transistors "off" |  |  | 5.0 | $\mu \mathrm{A}$ |
|  |  | Vo $=$ Vss, Pullup OFF Output transistors "off" |  |  | -5.0 | $\mu \mathrm{A}$ |

Table 22 Electrical characteristics (2) (Vcc =2.5 to 5.5 V , $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| Vram | RAM retention voltage | At clock stop mode |  | 2.0 |  | 5.5 | V |
| ICC | Power source current | - High-speed mode, Vcc = 5 V $\begin{aligned} & f(\mathrm{XIN})=8 \mathrm{MHz} \\ & \mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" A-D converter in operating |  |  | 8.0 | 15 | mA |
|  |  | - High-speed mode, Vcc $=5 \mathrm{~V}$ $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ (in WIT state) $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ <br> Output transistors "off" A-D converter stop |  |  | 2.5 | 4.0 | mA |
|  |  | - Low-speed mode, $\mathrm{VcC}=5 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\mathrm{f}(\mathrm{XIN})=$ stopped $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ <br> Output transistors "off" |  |  | 45 | 67 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{VcC}=5 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ $\mathrm{f}(\mathrm{XIN})=$ stopped $f(X C I N)=32.768 \mathrm{kHz}$ (in WIT state) Output transistors "off" |  |  | 23 | 46 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{VCC}=3 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & f(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 18 | 36 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ <br> $\mathrm{f}(\mathrm{XIN})=$ stopped <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 8 | 16 | $\mu \mathrm{A}$ |
|  |  | All oscillation stopped (in STP state) Output transistors "off" (M3826AEF) | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.1 | 1.0 |  |
|  |  |  | $\mathrm{Ta}=85^{\circ} \mathrm{C}$ |  |  | 10 | $\mu \mathrm{A}$ |
|  |  | All oscillation stopped (in STP state) Output transistors "off" (M38267E8) | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.5 | 10 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{Ta}=55^{\circ} \mathrm{C}$ |  |  | 60 |  |
| VL1 | Power source voltage | When using voltage multiplier |  | 1.3 | 1.8 | 2.3 | V |
| IL1 | Power source current (VL1) <br> (Note) | V L1 $=1.8 \mathrm{~V}$ |  |  | 4.0 |  | $\mu \mathrm{A}$ |

Note: When the voltage multiplier control bit of the LCD mode register (bit 4 at address 003916) is " 1 ".

Table 23 A-D converter characteristics
(Vcc = 2.7 to 5.5 V , Vss = AVss $=0 \mathrm{~V}$, $\mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}, 500 \mathrm{kHz} \leq \mathrm{f}(\mathrm{XIN}) \leq 8 \mathrm{MHz}$, in middle/high-speed mode unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| - | Resolution |  |  |  | 8 | Bits |
| - | Absolute accuracy (excluding quantization error) | $\mathrm{VCC}=\mathrm{VREF}=2.7$ to 5.5 V |  |  | $\pm 2$ | LSB |
| tCONV | Conversion time | $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ |  |  | $\begin{gathered} \hline 12.5 \\ \text { (Note) } \\ \hline \end{gathered}$ | $\mu \mathrm{S}$ |
| Rladder | Ladder resistor |  | 12 | 35 | 100 | $\mathrm{k} \Omega$ |
| IVREF | Reference power source input current | Vref $=5 \mathrm{~V}$ | 50 | 150 | 200 | $\mu \mathrm{A}$ |
| IIA | Analog port input current |  |  |  | 5.0 | $\mu \mathrm{A}$ |

Note: When an internal trigger is used in middle-speed mode, it is $14 \mu \mathrm{~s}$.

Table 24 D-A converter characteristics
(Vcc = 2.7 to $5.5 \mathrm{~V}, \mathrm{Vcc}=\mathrm{VREF}, \mathrm{Vss}=\mathrm{AVss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, in middle/high-speed mode unless otherwise noted)

| Symbol | Parameter |  | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| - | Resolution |  |  |  |  |  | 8 | Bits |
| - | Absolute accuracy |  | $\mathrm{VCC}=\mathrm{VREF}=5 \mathrm{~V}$ |  |  | 1.0 | \% |
|  |  |  | $\mathrm{VCC}=\mathrm{VREF}=2.7 \mathrm{~V}$ |  |  | 2.0 | \% |
| tsu | Setting time |  |  |  | 3 |  | $\mu \mathrm{s}$ |
| Ro | Output resistor |  |  | 1 | 2.5 | 4 | $\mathrm{k} \Omega$ |
| IVREF | Reference power source input current | M3826AEF | (Note) |  |  | 3.2 | mA |
|  |  | M38267E8 | (Note) |  |  | 6.0 | mA |

Note: Using one D-A converter, with the value in the D-A conversion register of the other D-A converter being "0016", and excluding currents flowing through the A-D resistance ladder.

# MITSUBISHI MICROCOMPUTERS <br> 3826 Group 

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Table 25 Timing requirements 1 ( $\mathrm{Vcc}=4.0$ to 5.5 V , $\mathrm{Vss}=\mathbf{0 V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\mathrm{RESET}})$ | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTRo, CNTR1 input cycle time | 250 |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 105 |  |  | ns |
| twL(CNTR) | CNTRo, CNTR1 input "L" pulse width | 105 |  |  | ns |
| twH(INT) | INT0 to INT2 input "H" pulse width | 80 |  |  | ns |
| twL(INT) | INT0 to INT2 input "L" pulse width | 80 |  |  | ns |
| tc(Sclki) | Serial I/O1 clock input cycle time (Note) | 800 |  |  | ns |
| twH(ScLK1) | Serial I/O1 clock input "H" pulse width (Note) | 370 |  |  | ns |
| twL(ScLK1) | Serial I/O1 clock input "L" pulse width (Note) | 370 |  |  | ns |
| tsu(RxD-ScLK1) | Serial I/O1 input set up time | 220 |  |  | ns |
| th(ScLK1-RxD) | Serial I/O1 input hold time | 100 |  |  | ns |
| tc(Sclk2) | Serial I/O2 clock input cycle time (Note) | 1000 |  |  | ns |
| twH(Sclk2) | Serial I/O2 clock input "H" pulse width (Note) | 400 |  |  | ns |
| twL(Sclk2) | Serial I/O2 clock input "L" pulse width (Note) | 400 |  |  | ns |
| tsu(SIN2-ScLK2) | Serial I/O2 input set up time | 200 |  |  | ns |
| th(ScLK2-Sin2) | Serial 1/O2 input hold time | 200 |  |  | ns |

Note: When bit 6 of address 001 A 16 is " 1 ",
Divide this value by four when bit 6 of address 001 A16 is " 0 ".

Table 26 Timing requirements 2 ( $\mathrm{Vcc}=2.5$ to $4.0 \mathrm{~V}, \mathrm{Vss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\text { RESET }}$ ) | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{S}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(Xin) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTRo, CNTR1 input cycle time | 500/(Vcc-2) |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 250/(Vcc-2)-20 |  |  | ns |
| twL(CNTR) | CNTRo, CNTR1 input "L" pulse width | 250/(Vcc-2)-20 |  |  | ns |
| twH(INT) | INT0 to INT2 input "H" pulse width | 230 |  |  | ns |
| twL(INT) | INT0 to INT2 input "L" pulse width | 230 |  |  | ns |
| tc(Sclki) | Serial I/O1 clock input cycle time (Note) | 2000 |  |  | ns |
| twH(ScLk1) | Serial I/O1 clock input "H" pulse width (Note) | 950 |  |  | ns |
| twL(ScLK1) | Serial I/O1 clock input "L" pulse width (Note) | 950 |  |  | ns |
| tsu(RxD-ScLK1) | Serial l/O1 input set up time | 400 |  |  | ns |
| th(ScLK1-RxD) | Serial I/O1 input hold time | 200 |  |  | ns |
| tc(Sclk2) | Serial I/O2 clock input cycle time (Note) | 2000 |  |  | ns |
| twH(Sclkz) | Serial I/O2 clock input "H" pulse width (Note) | 950 |  |  | ns |
| twL(Sclk2) | Serial I/O2 clock input "L" pulse width (Note) | 950 |  |  | ns |
| tsu(SIN2-Sclk2) | Serial I/O2 input set up time | 400 |  |  | ns |
| th(Sclk2-SIN2) | Serial I/O2 input hold time | 300 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 ".
Divide this value by four when bit 6 of address 001A16 is " 0 ".

Table 27 Switching characteristics 1 ( $\mathrm{Vcc}=4.0$ to 5.5 V , $\mathrm{Vss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(Sclkı) | Serial I/O1 clock output "H" pulse width | tc (SCLK1)/2-30 |  |  | ns |
| twL(ScLK1) | Serial I/O1 clock output "L" pulse width | tc (SCLK1)/2-30 |  |  | ns |
| td(ScLK1-TxD) | Serial I/O1 output delay time (Note 1) |  |  | 140 | ns |
| tv(ScLk1-TxD) | Serial I/O1 output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (SCLK1) | Serial I/O1 clock output rising time |  |  | 30 | ns |
| tf(ScLK1) | Serial I/O1 clock output falling time |  |  | 30 | ns |
| twH(Sclk2) | Serial I/O2 clock output "H" pulse width | tc (SCLK2)/2-160 |  |  | ns |
| twL(Sclk2) | Serial I/O2 clock output "L" pulse width | tc (SCLK2)/2-160 |  |  | ns |
| td(ScLK2-Sout2) | Serial I/O2 output delay time |  |  | $0.2 \times$ tc (SCLK2) | ns |
| tv(SCLK2-Sout2) | Serial I/O2 output valid time | 0 |  |  | ns |
| tf (ScLK2) | Serial I/O2 clock output falling time |  |  | 40 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 10 | 30 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 10 | 30 | ns |

Notes 1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: Xout and Xcout pins are excluded.

Table 28 Switching characteristics $2\left(\mathrm{Vcc}=2.5\right.$ to 4.0 V , $\mathrm{Vss}=0 \mathrm{~V}, \mathrm{Ta}=\mathbf{- 2 0}$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(Sclki) | Serial I/O1 clock output "H" pulse width | tc (SCLK1)/2-50 |  |  | ns |
| twL(Sclkı) | Serial I/O1 clock output "L" pulse width | tc (SCLK1)/2-50 |  |  | ns |
| td(ScLK1-TxD) | Serial I/O1 output delay time (Note 1) |  |  | 350 | ns |
| tv(ScLK1-TxD) | Serial I/O1 output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}$ (SCLK1) | Serial I/O1 clock output rising time |  |  | 50 | ns |
| tf(ScLK1) | Serial I/O1 clock output falling time |  |  | 50 | ns |
| twH(ScLK2) | Serial I/O2 clock output "H" pulse width | tc (SCLK2)/2-240 |  |  | ns |
| twL(Sclk2) | Serial I/O2 clock output "L" pulse width | tc (SCLK2)/2-240 |  |  | ns |
| td(Sclı2-Sout2) | Serial I/O2 output delay time |  |  | $0.2 \times$ tc (SCLK2) | ns |
| tv(Sclk2-Sout2) | Serial I/O2 output valid time | 0 |  |  | ns |
| tf(ScLk2) | Serial I/O2 clock output falling time |  |  | 50 | ns |
| $\operatorname{tr}$ (CMOS) | CMOS output rising time (Note 2) |  | 20 | 50 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 20 | 50 | ns |

Notes1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is "0".
2: Xout and Xcout pins are excluded.

## ELECTRICAL CHARACTERISTICS (Low Voltage Version)

## ABSOLUTE MAXIMUM RATINGS (Low Voltage Version)

Table 29 Absolute maximum ratings (low voltage version)

| Symbol | Parameter | Conditions | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Vcc | Power source voltage (Note 1) | All voltages are based on Vss. Output transistors are cut off. | -0.3 to 6.5 | V |
| VI | Input voltage $\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 17, \mathrm{P} 20-\mathrm{P} 27$, <br>  $\mathrm{P} 40-\mathrm{P} 47, \mathrm{P} 50-\mathrm{P} 57, \mathrm{P} 60-\mathrm{P} 67$ |  | -0.3 to Vcc +0.3 | V |
| VI | Input voltage P70-P77 |  | -0.3 to Vcc +0.3 | V |
| VI | Input voltage VL1 |  | -0.3 to VL2 | V |
| VI | Input voltage VL2 |  | VL1 to VL3 | V |
| VI | Input voltage VL3 (Note 2) |  | VL2 to 6.5 | V |
| VI | Input voltage $\mathrm{C}_{1}, \mathrm{C} 2$ (Note 1) |  | -0.3 to 6.5 | V |
| VI | Input voltage RESET, XIN |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage C1, C2 (Note 1) |  | -0.3 to 6.5 | V |
| Vo | Output voltage P00-P07, P10-P15, P30-P37 | At output port | -0.3 to Vcc | V |
|  |  | At segment output | -0.3 to VL3 | V |
| Vo | $\begin{array}{r} \hline \text { Output voltage P16, P17, P20-P27, P40-P47, } \\ \text { P50-P57, P60-P67, P71-P77 } \\ \hline \end{array}$ |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage VL3 (Note 1) |  | -0.3 to 6.5 | V |
| Vo | Output voltage VL2, SEG0-SEG17 |  | -0.3 to VL3 | V |
| Vo | Output voltage Xout |  | -0.3 to Vcc +0.3 | V |
| Pd | Power dissipation | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | 300 | mW |
| Topr | Operating temperature |  | -20 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Tstg | Storage temperature |  | -40 to 125 | ${ }^{\circ} \mathrm{C}$ |

Notes 1: -0.3 V to 7.0 V for M38267M8L.
2: VL2 to 7.0 V for M38267M8L.
RECOMMENDED OPERATING CONDITIONS (Low Voltage Version)
Table 30 Recommended operating conditions (1) (low voltage version) (Vcc = 2.2 to $5.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Vcc | Power source voltage | High-speed mode $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ | 4.0 | 5.0 | 5.5 | V |
|  |  | Middle-speed mode $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ | 2.2 | 5.0 | 5.5 |  |
|  |  | Low-speed mode | 2.2 | 5.0 | 5.5 |  |
| Vss | Power source voltage |  |  | 0 |  | V |
| Vref | A-D, D-A conversion reference voltage |  | 2.0 |  | Vcc | V |
| AVss | Analog power source voltage |  |  | 0 |  | V |
| VIA | Analog input voltage AN0-AN7 |  | AVss |  | Vcc | V |

Table 31 Recommended operating conditions (2) (low voltage version) (Vcc = 2.5 to $5.5 \mathrm{~V}, \mathrm{Ta}=\mathbf{- 2 0}$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VIH | " H " input voltage | $\begin{aligned} & \text { P00-P07, P10-P17, P40, P43, P45, P47, P50-P53, } \\ & \text { P56, P61, P64-P67, P71-P77 } \end{aligned}$ | 0.7 Vcc |  | Vcc | V |
| VIH | " H " input voltage | $\begin{aligned} & \text { P20-P27, P41, P42, P44, P46, P54, P55, P57, P60, } \\ & \text { P62, P63, P70 } \end{aligned}$ | 0.8 Vcc |  | Vcc | V |
| VIH | " H " input voltage | RESET | 0.8 Vcc |  | Vcc | V |
| VIH | "H" input voltage | XIN | 0.8 Vcc |  | Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17, P40, P43, P45, P47, P50-P53, } \\ & \text { P56, P61, P64-P67, P71-P77 } \end{aligned}$ | 0 |  | 0.3 Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P20-P27, P41, P42, P44, P46, P54, P55, P57, P60, } \\ & \text { P62, P63, P70 } \end{aligned}$ | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | RESET | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | XIN | 0 |  | 0.2 Vcc | V |

Table 32 Recommended operating conditions (3) (low voltage version) (Vcc = 2.2 to $2.5 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VIH | " H " input voltage | $\begin{aligned} & \text { P00-P07, P10-P17, P40, P43, P45, P47, P50-P53, } \\ & \text { P56, P61, P64-P67, P71-P77 } \end{aligned}$ | 0.8 Vcc |  | Vcc | V |
| VIH | " H " input voltage | $\begin{aligned} & \text { P20-P27, P41, P42, P44, P46, P54, P55, P57, P60, } \\ & \text { P62, P63, P70 } \end{aligned}$ | 0.95 Vcc |  | Vcc | V |
| VIH | " H " input voltage | RESET | 0.95 Vcc |  | Vcc | V |
| VIH | "H" input voltage | XIN | 0.95 Vcc |  | Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P00-P07, P10-P17, P40, P43, P45, P47, P50-P53, } \\ & \text { P56, P61, P64-P67, P71-P77 } \end{aligned}$ | 0 |  | 0.2 Vcc | V |
| VIL | "L" input voltage | $\begin{aligned} & \text { P20-P27, P41, P42, P44, P46, P54, P55, P57, P60, } \\ & \text { P62, P63, P70 } \end{aligned}$ | 0 |  | 0.05 Vcc | V |
| VIL | "L" input voltage | RESET | 0 |  | 0.05 Vcc | V |
| VIL | "L" input voltage | XIN | 0 |  | 0.05 Vcc | V |

Table 33 Recommended operating conditions（4）（low voltage version）（Vcc＝ 2.2 to $5.5 \mathrm{~V}, \mathrm{Ta}=\mathbf{- 2 0}$ to $85^{\circ} \mathrm{C}$ ，unless otherwise noted）

| Symbol | Parameter |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min． | Typ． | Max． |  |
| $\mathrm{\Sigma lOH}$（peak） | ＂ H ＂total peak output current | P00－P07，P10－P17，P20－P27，P30－P37（Note 1） |  |  | －20 | mA |
| ElOH（peak） | ＂H＂total peak output current | P41－P47，P50－P57，P60－P67（Note 1） |  |  | －20 | mA |
| ミlOL（peak） | ＂L＂total peak output current | P00－P07，P10－P17，P20－P27，P30－P37（Note 1） |  |  | 20 | mA |
| ミlOL（peak） | ＂L＂total peak output current | P41－P47，P50－P57，P60－P67（Note 1） |  |  | 20 | mA |
| ミlOL（peak） | ＂L＂total peak output current | P40，P71－P77（Note 1） |  |  | 80 | mA |
| Eloh（avg） | ＂H＂total average output current | P00－P07，P10－P17，P20－P27，P30－P37（Note 1） |  |  | －10 | mA |
| ElOH（avg） | ＂H＂total average output current | P41－P47，P50－P57，P60－P67（Note 1） |  |  | －10 | mA |
| EloL（avg） | ＂L＂total average output current | P00－P07，P10－P17，P20－P27，P30－P37（Note 1） |  |  | 10 | mA |
| EloL（avg） | ＂L＂total average output current | P41－P47，P50－P57，P60－P67（Note 1） |  |  | 10 | mA |
| EloL（avg） | ＂L＂total average output current | $\mathrm{P} 40, \mathrm{P} 71-\mathrm{P} 77$（Note 1） |  |  | 40 | mA |
| IOH （peak） | ＂H＂peak output current | P00－P07，P10－P15，P30－P37（Note 2） |  |  | －1．0 | mA |
| IOH （peak） | ＂H＂peak output current | P16, P17, P20-P27, P41-P47, P50-P57, P60-P67 (Note 2) |  |  | －5．0 | mA |
| IOL（peak） | ＂L＂peak output current | P00－P07，P10－P15，P30－P37（Note 2） |  |  | 5.0 | mA |
| IOL（peak） | ＂L＂peak output current | P16，P17，P20－P27，P41－P47，P50－P57，P60－P67 （Note 2） |  |  | 10 | mA |
| IOL（peak） | ＂L＂peak output current | P40，P71－P77（Note 2） |  |  | 20 | mA |
| $\mathrm{IOH}(\mathrm{avg})$ | ＂H＂average output current | P00－P07，P10－P15，P30－P37（Note 3） |  |  | －0．5 | mA |
| IOH（avg） | ＂H＂average output current | P16，P17，P20－P27，P41－P47，P50－P57，P60－P67 |  |  | －2．5 | mA |
| IOL（avg） | ＂L＂average output current | $\mathrm{P} 00-\mathrm{P} 07, \mathrm{P} 10-\mathrm{P} 15, \mathrm{P} 30-\mathrm{P} 37$（Note 3） |  |  | 2.5 | mA |
| IOL（avg） | ＂L＂average output current | P16，P17，P20－P27，P41－P47，P50－P57，P60－P67 （Note 3） |  |  | 5.0 | mA |
| IOL（avg） | ＂L＂average output current | P40，P71－P77（Note 3） |  |  | 10 | mA |

Notes1：The total output current is the sum of all the currents flowing through all the applicable ports．The total average current is an average value measured over 100 ms ．The total peak current is the peak value of all the currents．
2：The peak output current is the peak current flowing in each port．
3：The average output current is an average value measured over 100 ms ．

Table 34 Recommended operating conditions (5) (low voltage version) ( $\mathrm{Vcc}=\mathbf{2 . 2}$ to $5.5 \mathrm{~V}, \mathrm{Ta}=\mathbf{- 2 0}$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| f(CNTRo) <br> f(CNTR1) | Input frequency for timers X and Y (duty cycle 50\%) | $(4.0 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V})$ |  |  | 4.0 | MHz |
|  |  | $(\mathrm{Vcc} \leq 4.0 \mathrm{~V})$ |  |  | $\begin{array}{r} \hline(10 \times V \mathrm{Vc} \\ -4) / 9 \end{array}$ | MHz |
| $f(X I N)$ | Main clock input oscillation frequency (Note 1) | High-speed mode $(4.0 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V})$ |  |  | 8.0 | MHz |
|  |  | High-speed mode $(2.2 \mathrm{~V} \leq \mathrm{VCc} \leq 4.0 \mathrm{~V})$ |  |  | $\begin{array}{\|r\|} \hline(20 \times \mathrm{Vcc} \\ -8) / 9 \end{array}$ | MHz |
|  |  | Middle-speed mode |  |  | 8.0 | MHz |
| f (XCIN) | Sub-clock input oscillation frequency (Notes 1, 2) |  |  | 32.768 | 50 | kHz |

Notes1: When the oscillation frequency has a duty cycle of $50 \%$.
2: When using the microcomputer in low-speed mode, make sure that the sub-clock input oscillation frequency on condition that $f(\operatorname{XcIN})<f(X I N) / 3$.

Table 35 Electrical characteristics (1) (low voltage version) (Vcc $=4.0$ to $5.5 \mathrm{~V}, \mathrm{Ta}=\mathbf{- 2 0}$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Voh | "H" output voltage <br> P00-P07, P10-P15, P30-P37 | $\mathrm{IOH}=-1 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\begin{aligned} & \text { IOH }=-0.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.2 \mathrm{~V} \end{aligned}$ | Vcc-0.8 |  |  | V |
| Voh | "H" output voltage <br> P16, P17, P20-P27, P41-P47, P50-P57, <br> P60-P67 (Note 1) | $\mathrm{IOH}=-5 \mathrm{~mA}$ | Vcc-2.0 |  |  | V |
|  |  | $\mathrm{IOH}=-1.5 \mathrm{~mA}$ | Vcc-0.5 |  |  | V |
|  |  | $\begin{aligned} & \mathrm{IOH}=-1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.2 \mathrm{~V} \end{aligned}$ | Vcc-0.8 |  |  | V |
| Vol | "L" output voltage <br> P00-P07, P10-P15, P30-P37 | $\mathrm{IOL}=5 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=1.5 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=1.25 \mathrm{~mA} \\ & \mathrm{VCC}=2.2 \mathrm{~V} \\ & \hline \end{aligned}$ |  |  | 0.8 | V |
| Vol | "L" output voltage <br> P16, P17, P20-P27, P41-P47, P50-P57, P60-P67 | $\mathrm{IOL}=10 \mathrm{~mA}$ |  |  | 2.0 | V |
|  |  | $\mathrm{IOL}=3.0 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=2.5 \mathrm{~mA} \\ & \mathrm{Vcc}=2.2 \mathrm{~V} \\ & \hline \end{aligned}$ |  |  | 0.8 | V |
| Vol | "L" output voltage P40, P71-P77 | $\mathrm{IOL}=10 \mathrm{~mA}$ |  |  | 0.5 | V |
|  |  | $\begin{aligned} & \mathrm{IOL}=5 \mathrm{~mA} \\ & \mathrm{VCC}=2.2 \mathrm{~V} \end{aligned}$ |  |  | 0.3 | V |
| $\mathrm{VT}_{+}$- $\mathrm{VT}^{\text {- }}$ | Hysteresis INT0-INT2, ADT, CNTR0, CNTR1, P20-P27 |  |  | 0.5 |  | V |
|  | Hysteresis ScLK, RxD, SIN2 |  |  | 0.5 |  | V |
| $\mathrm{V}_{+}^{+}$- $\mathrm{V}^{\text {T- }}$ | Hysteresis RESET |  |  | 0.5 |  | V |
| IIH | "H" input current P00-P07, P10-P17, P20-P27, P40-P47, P50-P57, P60-P67, P70-P77 | V I $=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current $\overline{\text { RESET }}$ | V I $=\mathrm{Vcc}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| IIH | "H" input current XIN | $\mathrm{V}_{1}=\mathrm{Vcc}$ |  | 4.0 |  | $\mu \mathrm{A}$ |
| IIL | "L" input current$\begin{aligned} & \text { P00-P07,P10-P17, P20-P27,P41-P47, } \\ & \text { P50-P57, P60-P67 } \end{aligned}$ | $\mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "off" |  |  | -5.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=5 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -60.0 | -120.0 | -240.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=2.2 \mathrm{~V}, \mathrm{VI}=\mathrm{Vss}$ <br> Pull-ups "on" | -5.0 | -20.0 | -40.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current P40, P70-P77 |  |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current $\overline{\text { RESET }}$ | V I $=\mathrm{V}$ SS |  |  | -5.0 | $\mu \mathrm{A}$ |
| IIL | "L" input current XIN | $\mathrm{V}_{1}=\mathrm{Vss}$ |  | -4.0 |  | $\mu \mathrm{A}$ |
| ILOAD | Output load current P30-P37 | Vcc $=5.0 \mathrm{~V}$, Vo = Vcc, Pullup ON Output transistors "off" | -60.0 | -120.0 | -240.0 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{Vcc}=2.2 \mathrm{~V}, \mathrm{Vo}=\mathrm{Vcc}$, Pullup ON Output transistors "off" | -5.0 | -20.0 | -40.0 | $\mu \mathrm{A}$ |
| ILEAK | Output leak current P30-P37 | Vo = Vcc, Pullup OFF Output transistors "off" |  |  | 5.0 | $\mu \mathrm{A}$ |
|  |  | Vo $=$ Vss, Pullup OFF Output transistors "off" |  |  | -5.0 | $\mu \mathrm{A}$ |

Table 36 Electrical characteristics (2) (low voltage version) (Vcc =2.2 to $5.5 \mathrm{~V}, \mathrm{Ta}=\mathbf{- 2 0}$ to $\mathbf{8 5}{ }^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Test conditions |  | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| Vram | RAM retention voltage | At clock stop mode |  | 2.0 |  | 5.5 | V |
| ICC | Power source current | - High-speed mode, Vcc = 5 V $\begin{aligned} & f(\mathrm{XIN})=8 \mathrm{MHz} \\ & f(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" <br> A-D converter in operating |  |  | 8.0 | 15 | mA |
|  |  | $\begin{aligned} & \text { - High-speed mode, VcC = } 5 \mathrm{~V} \\ & \mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz} \text { (in WIT state) } \\ & \mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz} \\ & \text { Output transistors "off" } \\ & \text { A-D converter stop } \\ & \hline \end{aligned}$ |  |  | 2.5 | 4.0 | mA |
|  |  | - Low-speed mode, Vcc $=5 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & \mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 45 | 67 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, Vcc $=5 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ $\mathrm{f}(\mathrm{XIN})=\text { stopped }$ <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 23 | 46 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{Ta} \leq 55^{\circ} \mathrm{C}$ $\begin{aligned} & f(\mathrm{XIN})=\text { stopped } \\ & \mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz} \end{aligned}$ <br> Output transistors "off" |  |  | 18 | 36 | $\mu \mathrm{A}$ |
|  |  | - Low-speed mode, $\mathrm{Vcc}=3 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}$ <br> $\mathrm{f}(\mathrm{XIN})=$ stopped <br> $\mathrm{f}(\mathrm{XCIN})=32.768 \mathrm{kHz}$ (in WIT state) <br> Output transistors "off" |  |  | 8 | 16 | $\mu \mathrm{A}$ |
|  |  | All oscillation stopped (in STP state) Output transistors "off" <br> (M38268MCL, M3826AMFL) | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.1 | 1.0 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{Ta}=85^{\circ} \mathrm{C}$ |  |  | 10 |  |
|  |  | All oscillation stopped (in STP state) Output transistors "off" <br> (M38267M8L) | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ |  | 0.5 | 10 | A |
|  |  |  | $\mathrm{Ta}=55^{\circ} \mathrm{C}$ |  |  | 60 | $\mu \mathrm{A}$ |
| VL1 | Power source voltage | When using voltage multiplier | $\begin{aligned} & \text { M38268MCL, } \\ & \text { M3826AMFL } \end{aligned}$ | 1.3 | 1.8 | 2.1 | V |
|  |  |  | M38267M8L | 1.3 | 1.8 | 2.3 |  |
| IL1 | Power source current (VL1) <br> (Note) | $\mathrm{VL1}=1.8 \mathrm{~V}$ |  |  | 4.0 |  | $\mu \mathrm{A}$ |

Note: When the voltage multiplier control bit of the LCD mode register (bit 4 at address 003916) is " 1 ".

Table 37 A-D converter characteristics (low voltage version)
( $\mathrm{VcC}=2.7$ to 5.5 V , Vss $=\mathrm{AVss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}, 500 \mathrm{kHz} \leq \mathrm{f}(\mathrm{XIN}) \leq 8 \mathrm{MHz}$, in middle/high-speed mode unless otherwise noted)

| Symbol | Parameter | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| - | Resolution |  |  |  | 8 | Bits |
| - | Absolute accuracy (excluding quantization error) | $\mathrm{VCC}=\mathrm{VREF}=2.7$ to 5.5 V |  |  | $\pm 2$ | LSB |
| tCONV | Conversion time | $\mathrm{f}(\mathrm{XIN})=8 \mathrm{MHz}$ |  |  | $\begin{gathered} 12.5 \\ \text { (Note) } \end{gathered}$ | $\mu \mathrm{s}$ |
| RLADDER | Ladder resistor |  | 12 | 35 | 100 | k $\Omega$ |
| IVREF | Reference power source input current | VREF $=5 \mathrm{~V}$ | 50 | 150 | 200 | $\mu \mathrm{A}$ |
| IIA | Analog port input current |  |  |  | 5.0 | $\mu \mathrm{A}$ |

Note: When an internal trigger is used in middle-speed mode, it is $14 \mu \mathrm{~s}$.

Table 38 D-A converter characteristics (low voltage version)
(Vcc = 2.7 to $5.5 \mathrm{~V}, \mathrm{Vcc}=\mathrm{VREF}, \mathrm{Vss}=\mathrm{AVss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, in middle/high-speed mode unless otherwise noted)

| Symbol | Parameter |  | Test conditions | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| - | Resolution |  |  |  |  |  | 8 | Bits |
| - | Absolute accuracy |  | $\mathrm{VCC}=\mathrm{VREF}=5 \mathrm{~V}$ |  |  | 1.0 | \% |
|  |  |  | $\mathrm{VCC}=\mathrm{VREF}=2.7 \mathrm{~V}$ |  |  | 2.0 | \% |
| tsu | Setting time |  |  |  | 3 |  | $\mu \mathrm{s}$ |
| Ro | Output resistor |  |  | 1 | 2.5 | 4 | $\mathrm{k} \Omega$ |
| IVREF | Reference power source input current | M38268MCL, M3826AMFL | (Note) |  |  | 3.2 | mA |
|  |  | M38267M8L | (Note) |  |  | 6.0 | mA |

Note: Using one D-A converter, with the value in the D-A conversion register of the other D-A converter being " 0016 ", and excluding currents flowing through the A-D resistance ladder.

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Table 39 Timing requirements 1 (low voltage version) (Vcc $=4.0$ to $5.5 \mathrm{~V}, \mathrm{Vss}=0 \mathrm{~V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\mathrm{RESET}})$ | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{s}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(XIN) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTRo, CNTR1 input cycle time | 250 |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | 105 |  |  | ns |
| twL(CNTR) | CNTRo, CNTR1 input "L" pulse width | 105 |  |  | ns |
| twH(INT) | INT0 to INT2 input "H" pulse width | 80 |  |  | ns |
| twL(INT) | INT0 to INT2 input "L" pulse width | 80 |  |  | ns |
| tc(Sclki) | Serial I/O1 clock input cycle time (Note) | 800 |  |  | ns |
| twH(ScLK1) | Serial I/O1 clock input "H" pulse width (Note) | 370 |  |  | ns |
| twL(ScLK1) | Serial I/O1 clock input "L" pulse width (Note) | 370 |  |  | ns |
| tsu(RxD-ScLK1) | Serial l/O1 input set up time | 220 |  |  | ns |
| th(Sclki-RxD) | Serial I/O1 input hold time | 100 |  |  | ns |
| tc(ScLk2) | Serial I/O2 clock input cycle time (Note) | 1000 |  |  | ns |
| twH(Sclk2) | Serial I/O2 clock input "H" pulse width (Note) | 400 |  |  | ns |
| twL(ScLK2) | Serial I/O2 clock input "L" pulse width (Note) | 400 |  |  | ns |
| tsu(SIN2-Sclk2) | Serial I/O2 input set up time | 200 |  |  | ns |
| th(Sclk2-Sin2) | Serial I/O2 input hold time | 200 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 ",
Divide this value by four when bit 6 of address 001 A16 is " 0 ".

Table 40 Timing requirements 2 (low voltage version) (Vcc $=2.2$ to 4.0 V , $\mathrm{Vss}=\mathbf{0 V} \mathrm{Va}=\mathbf{- 2 0}$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| tw( $\overline{\text { RESET }}$ ) | Reset input "L" pulse width | 2 |  |  | $\mu \mathrm{S}$ |
| tc(XIN) | Main clock input cycle time (XIN input) | 125 |  |  | ns |
| twh(Xiv) | Main clock input "H" pulse width | 45 |  |  | ns |
| twL(XIN) | Main clock input "L" pulse width | 40 |  |  | ns |
| tc(CNTR) | CNTRo, CNTR1 input cycle time | 900/(Vcc-0.4) |  |  | ns |
| twH(CNTR) | CNTR0, CNTR1 input "H" pulse width | tc(CNTR)/2-20 |  |  | ns |
| twL(CNTR) | CNTR0, CNTR1 input "L" pulse width | tc(CNTR)/2-20 |  |  | ns |
| twH(INT) | INT0 to INT2 input "H" pulse width | 230 |  |  | ns |
| twL(INT) | INT0 to INT2 input "L" pulse width | 230 |  |  | ns |
| tc(Sclki) | Serial I/O1 clock input cycle time (Note) | 2000 |  |  | ns |
| twH(ScLK1) | Serial I/O1 clock input "H" pulse width (Note) | 950 |  |  | ns |
| twL(ScLK1) | Serial I/O1 clock input "L" pulse width (Note) | 950 |  |  | ns |
| tsu(RxD-ScLK1) | Serial l/O1 input set up time | 400 |  |  | ns |
| th(ScLK1-RxD) | Serial I/O1 input hold time | 200 |  |  | ns |
| tc(Sclk2) | Serial I/O2 clock input cycle time (Note) | 2000 |  |  | ns |
| twH(Sclkz) | Serial I/O2 clock input "H" pulse width (Note) | 950 |  |  | ns |
| twL(Sclk2) | Serial I/O2 clock input "L" pulse width (Note) | 950 |  |  | ns |
| tsu(SIN2-Sclk2) | Serial I/O2 input set up time | 400 |  |  | ns |
| th(Sclk2-Sin2) | Serial I/O2 input hold time | 300 |  |  | ns |

Note: When bit 6 of address 001A16 is " 1 ".
Divide this value by four when bit 6 of address 001 A16 is " 0 ".

# MITSUBISHI MICROCOMPUTERS <br> 3826 Group 

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Table 41 Switching characteristics 1 (low voltage version) ( $\mathrm{Vcc}=4.0$ to 5.5 V , $\mathrm{Vss}=\mathbf{0} \mathrm{V}, \mathrm{Ta}=\mathbf{- 2 0}$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(Sclk1) | Serial I/O1 clock output "H" pulse width | tc (SCLK1)/2-30 |  |  | ns |
| twL(Sclk1) | Serial I/O1 clock output "L" pulse width | tc (SCLK1)/2-30 |  |  | ns |
| td(ScLk1-TxD) | Serial I/O1 output delay time (Note 1) |  |  | 140 | ns |
| tv(Sclki-TxD) | Serial I/O1 output valid time (Note 1) | -30 |  |  | ns |
| tr(ScLK1) | Serial I/O1 clock output rising time |  |  | 30 | ns |
| tf(Sclk1) | Serial I/O1 clock output falling time |  |  | 30 | ns |
| twH(ScLK2) | Serial I/O2 clock output "H" pulse width | tc (SCLK2)/2-160 |  |  | ns |
| twL(Scık2) | Serial I/O2 clock output "L" pulse width | tc (SCLK2)/2-160 |  |  | ns |
| td(ScLK2-Sout2) | Serial I/O2 output delay time |  |  | $0.2 \times$ tc (SCLK2) | ns |
| tv(ScLK2-Sout2) | Serial I/O2 output valid time | 0 |  |  | ns |
| tf(Sclk2) | Serial I/O2 clock output falling time |  |  | 40 | ns |
| tr(CMOS) | CMOS output rising time (Note 2) |  | 10 | 30 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 10 | 30 | ns |

Notes1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is " 0 ".
2: Xout and Xcout pins are excluded.

Table 42 Switching characteristics 2 (low voltage version) (Vcc =2.2 to $4.0 \mathrm{~V}, \mathrm{Vss}=\mathbf{0} \mathrm{V}, \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Parameter | Limits |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| twH(ScLK1) | Serial I/O1 clock output "H" pulse width | tc (SCLK1)/2-50 |  |  | ns |
| twL(ScLK1) | Serial I/O1 clock output "L" pulse width | tc (SCLK1)/2-50 |  |  | ns |
| td(ScLk1-TxD) | Serial I/O1 output delay time (Note 1) |  |  | 350 | ns |
| tv(SCLK1-TxD) | Serial I/O1 output valid time (Note 1) | -30 |  |  | ns |
| $\operatorname{tr}(\mathrm{SCLK1})$ | Serial I/O1 clock output rising time |  |  | 50 | ns |
| tf(ScLK1) | Serial I/O1 clock output falling time |  |  | 50 | ns |
| twH(ScLK2) | Serial I/O2 clock output "H" pulse width | tc (SCLK2)/2-240 |  |  | ns |
| twL(Sclk2) | Serial I/O2 clock output "L" pulse width | tc (SCLK2)/2-240 |  |  | ns |
| td(Sclk2-Sout2) | Serial I/O2 output delay time |  |  | $0.2 \times$ tc (SCLK2) | ns |
| tv(Sclk2-Sout2) | Serial I/O2 output valid time | 0 |  |  | ns |
| tf(ScLK2) | Serial I/O2 clock output falling time |  |  | 50 | ns |
| tr(CMOS) | CMOS output rising time (Note 2) |  | 20 | 50 | ns |
| tf(CMOS) | CMOS output falling time (Note 2) |  | 20 | 50 | ns |

Notes1: When the P45/TxD P-channel output disable bit of the UART control register (bit 4 of address 001B16) is "0".
2: Xout and Xcout pins are excluded.


Fig. 60 Circuit for measuring output switching characteristics


Fig. 61 Timing diagram

## PACKAGE OUTLINE



100P6S-A MMP
Plastic 100 pin $14 \times 20 \mathrm{~mm}$ body QFP


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